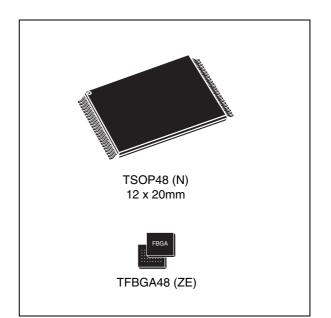


M29W320DT M29W320DB

32 Mbit (4Mbx8 or 2Mbx16, Non-uniform Parameter Blocks, Boot Block), 3V Supply Flash memory

Feature summary

- Supply Voltage
 - $V_{CC} = 2.7V$ to 3.6V for Program, Erase and Read
 - V_{PP} =12V for Fast Program (optional)
- Access time: 70, 90ns
- Programming time
 - 10µs per Byte/Word typical
- 67 memory blocks
 - 1 Boot Block (Top or Bottom Location)
 - 2 Parameter and 64 Main Blocks
- Program/Erase controller
 - Embedded Byte/Word Program algorithms
- Erase Suspend and Resume modes
 - Read and Program another Block during Erase Suspend
- Unlock Bypass Program command
 - Faster Production/Batch Programming
- V_{PP}/WP pin for Fast Program and Write Protect
- Temporary Block Unprotection mode
- Common Flash Interface
 - 64 bit Security code
- Low power consumption
 - Standby and Automatic Standby
- 100,000 Program/Erase cycles per block
- Electronic Signature
 - Manufacturer Code: 0020h
 - Top Device Code M29W320DT: 22CAh
 - Bottom Device Code M29W320DB: 22CBh
- ECOPACK[®] packages available



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1 Summary description

The M29W320D is a 32 Mbit (4Mb x8 or 2Mb x16) non-volatile memory that can be read, erased and reprogrammed. These operations can be performed using a single low voltage (2.7 to 3.6V) supply. On power-up the memory defaults to its Read mode where it can be read in the same way as a ROM or EPROM.

The memory is divided into blocks that can be erased independently so it is possible to preserve valid data while old data is erased. Each block can be protected independently to prevent accidental Program or Erase commands from modifying the memory. Program and Erase commands are written to the Command Interface of the memory. An on-chip Program/Erase Controller simplifies the process of programming or erasing the memory by taking care of all of the special operations that are required to update the memory contents. The end of a program or erase operation can be detected and any error conditions identified. The command set required to control the memory is consistent with JEDEC standards.

The blocks in the memory are asymmetrically arranged, see *Figure 4* and *Figure 5*, *Table 19* and *Table 20*. The first or last 64 Kbytes have been divided into four additional blocks. The 16 Kbyte Boot Block can be used for small initialization code to start the microprocessor, the two 8 Kbyte Parameter Blocks can be used for parameter storage and the remaining 32 Kbyte is a small Main Block where the application may be stored.

Chip Enable, Output Enable and Write Enable signals control the bus operation of the memory. They allow simple connection to most microprocessors, often without additional logic.

The memory is offered in TSOP48 (12 x 20mm), and TFBGA48 (6x8mm, 0.8mm pitch) packages. In order to meet environmental requirements, ST offers the M29W320D in ECOPACK[®] packages. ECOPACK packages are Lead-free. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

The memory is supplied with all the bits erased (set to 1).





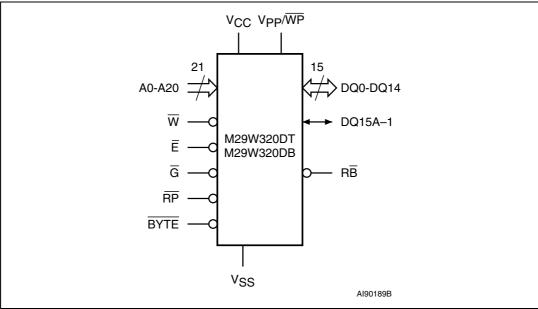


Table 1. Signal Name	es
A0-A20	Address Inputs
DQ0-DQ7	Data Inputs/Outputs
DQ8-DQ14	Data Inputs/Outputs
DQ15A-1	Data Input/Output or Address Input
Ē	Chip Enable
G	Output Enable
W	Write Enable
RP	Reset/Block Temporary Unprotect
RB	Ready/Busy Output
BYTE	Byte/Word Organization Select
V _{CC}	Supply Voltage
V _{PP} /WP	V _{PP} /Write Protect
V _{SS}	Ground
NC	Not Connected Internally

Signal Names Tabla 1



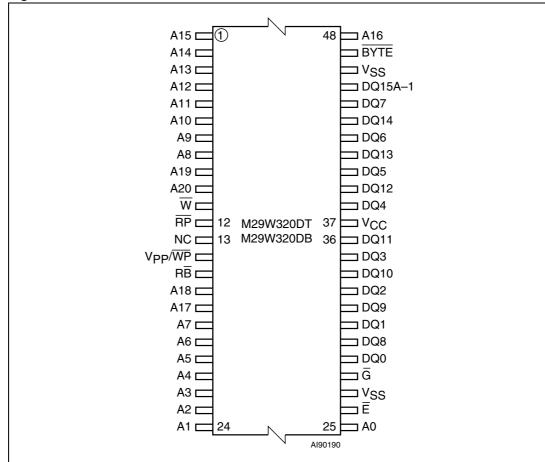


Figure 2. TSOP Connections



	1	2	3	4	5	6
A	• (A3)	A7	RĒ	(₩)	A9	A13
В	A4	A17	V _{PP} /WP	RP	A8	A12
с	A2	A6	A18	NC)	A10	A14
D	A1	A5	A20	A19	A11	A15
E	AO	DQ0	DQ2	DQ5	DQ7	A16
F	(E)	DQ8	(DQ10)	DQ12	DQ14 ;	BYTE
G	Ģ	DQ9	(DQ11)	V _{CC}	DQ13	DQ15 A-1
н	(V _{SS})	(DQ1)	DQ3	DQ4	DQ6	(V _{SS})

Figure 3. TFBGA48 Connections (Top view through package)



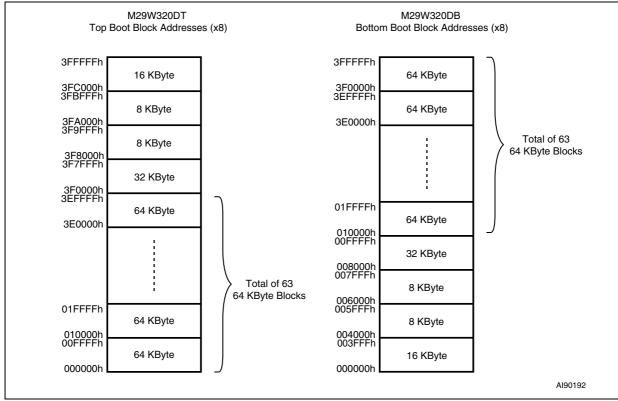


Figure 4. Block Addresses (x8)

1. Also see Appendix A: Block Addresses, Table 19 and Table 20 for a full listing of the Block Addresses.



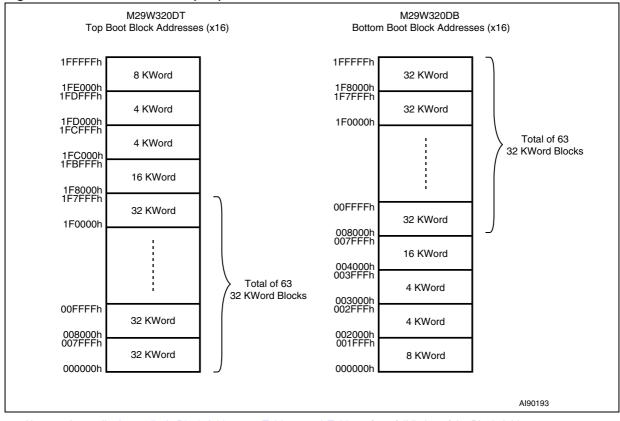


Figure 5. Block Addresses (x16)

1. Also see Appendix Appendix A: Block Addresses, Table 19 and Table 20 for a full listing of the Block Addresses.

5

2 Signal descriptions

See *Figure 1: Logic Diagram*, and *Table 1: Signal Names*, for a brief overview of the signals connected to this device.

2.1 Address Inputs (A0-A20)

The Address Inputs select the cells in the memory array to access during Bus Read operations. During Bus Write operations they control the commands sent to the Command Interface of the internal state machine.

2.2 Data Inputs/Outputs (DQ0-DQ7)

The Data I/O outputs the data stored at the selected address during a Bus Read operation. During Bus Write operations they represent the commands sent to the Command Interface of the internal state machine.

2.3 Data Inputs/Outputs (DQ8-DQ14)

The Data I/O outputs the data stored at the selected address during a Bus Read operation when $\overrightarrow{\text{BYTE}}$ is High, V_{IH}. When $\overrightarrow{\text{BYTE}}$ is Low, V_{IL}, these pins are not used and are high impedance. During Bus Write operations the Command Register does not use these bits. When reading the Status Register these bits should be ignored.

2.4 Data Input/Output or Address Input (DQ15A–1)

When $\overrightarrow{\text{BYTE}}$ is High, V_{IH}, this pin behaves as a Data Input/Output pin (as DQ8-DQ14). When $\overrightarrow{\text{BYTE}}$ is Low, V_{IL}, this pin behaves as an address pin; DQ15A–1 Low will select the LSB of the Word on the other addresses, DQ15A–1 High will select the MSB. Throughout the text consider references to the Data Input/Output to include this pin when $\overrightarrow{\text{BYTE}}$ is High and references to the Address Inputs to include this pin when $\overrightarrow{\text{BYTE}}$ is Low except when stated explicitly otherwise.

2.5 Chip Enable (\overline{E})

The Chip Enable, \overline{E} , activates the memory, allowing Bus Read and Bus Write operations to be performed. When Chip Enable is High, V_{IH}, all other pins are ignored.

2.6 Output Enable (G)

The Output Enable, \overline{G} , controls the Bus Read operation of the memory.



2.7 Write Enable (W)

The Write Enable, \overline{W} , controls the Bus Write operation of the memory's Command Interface.

2.8 V_{PP/}Write Protect (V_{PP}/WP)

The V_{PP} /Write Protect pin provides two functions. The V_{PP} function allows the memory to use an external high voltage power supply to reduce the time required for Unlock Bypass Program operations. The Write Protect function provides a hardware method of protecting the 16 Kbyte Boot Block. The V_{PP} /Write Protect pin must not be left floating or unconnected.

When V_{PP} /Write Protect is Low, V_{IL} , the memory protects the 16 Kbyte Boot Block; Program and Erase operations in this block are ignored while V_{PP} /Write Protect is Low.

When V_{PP} /Write Protect is High, V_{IH} , the memory reverts to the previous protection status of the 16 Kbyte boot block. Program and Erase operations can now modify the data in the 16 Kbyte Boot Block unless the block is protected using Block Protection.

When V_{PP} /Write Protect is raised to V_{PP} the memory automatically enters the Unlock Bypass mode. When V_{PP} /Write Protect returns to V_{IH} or V_{IL} normal operation resumes. During Unlock Bypass Program operations the memory draws I_{PP} from the pin to supply the programming circuits. See the description of the Unlock Bypass command in the Command Interface section. The transitions from V_{IH} to V_{PP} and from V_{PP} to V_{IH} must be slower than t_{VHVPP} see *Figure 13*.

Never raise V_{PP} /Write Protect to V_{PP} from any mode except Read mode, otherwise the memory may be left in an indeterminate state.

A 0.1 μ F capacitor should be connected between the V_{PP}/Write Protect pin and the V_{SS} Ground pin to decouple the current surges from the power supply. The PCB track widths must be sufficient to carry the currents required during Unlock Bypass Program, I_{PP}

2.9 Reset/Block Temporary Unprotect (RP)

The Reset/Block Temporary Unprotect pin can be used to apply a Hardware Reset to the memory or to temporarily unprotect all Blocks that have been protected.

Note that if V_{PP}/\overline{WP} is at V_{IL} , then the 16 KByte outermost boot block will remain protect even if RP is at V_{ID} .

A Hardware Reset is achieved by holding Reset/Block Temporary Unprotect Low, V_{IL} , for at least t_{PLPX} . After Reset/Block Temporary Unprotect goes High, V_{IH} , the memory will be ready for Bus Read and Bus Write operations after t_{PHEL} or t_{RHEL} , whichever occurs last. See the Ready/Busy Output section, *Table 15* and *Figure 12*, for more details.

Holding \overline{RP} at V_{ID} will temporarily unprotect the protected Blocks in the memory. Program and Erase operations on all blocks will be possible. The transition from V_{IH} to V_{ID} must be slower than t_{PHPHH}.



2.10 Ready/Busy Output (RB)

The Ready/Busy pin is an open-drain output that can be used to identify when the device is performing a Program or Erase operation. During Program or Erase operations Ready/Busy is Low, V_{OL}. Ready/Busy is high-impedance during Read mode, Auto Select mode and Erase Suspend mode.

Note that if V_{PP}/\overline{WP} is at V_{IL} , then the 16 KByte outermost boot block will remain protect even if RP is at V_{ID} .

After a Hardware Reset, Bus Read and Bus Write operations cannot begin until Ready/Busy becomes high-impedance. See *Table 15* and *Figure 12*.

The use of an open-drain output allows the Ready/Busy pins from several memories to be connected to a single pull-up resistor. A Low will then indicate that one, or more, of the memories is busy.

2.11 Byte/Word Organization Select (BYTE)

The Byte/Word Organization Select pin is used to switch between the x8 and x16 Bus modes of the memory. When Byte/Word Organization Select is Low, V_{IL} , the memory is in x8 mode, when it is High, V_{IH} , the memory is in x16 mode.

2.12 V_{CC} Supply Voltage

V_{CC} provides the power supply for all operations (Read, Program and Erase).

The Command Interface is disabled when the V_{CC} Supply Voltage is less than the Lockout Voltage, V_{LKO}. This prevents Bus Write operations from accidentally damaging the data during power up, power down and power surges. If the Program/Erase Controller is programming or erasing during this time then the operation aborts and the memory contents being altered will be invalid.

A 0.1 μ F capacitor should be connected between the V_{CC} Supply Voltage pin and the V_{SS} Ground pin to decouple the current surges from the power supply. The PCB track widths must be sufficient to carry the currents required during Program and Erase operations, I_{CC3}.

2.13 V_{SS} Ground

 V_{SS} is the reference for all voltage measurements.





3 Bus operations

There are five standard bus operations that control the device. These are Bus Read, Bus Write, Output Disable, Standby and Automatic Standby. See *Table 2* and *Table 3*, Bus operations, for a summary. Typically glitches of less than 5ns on Chip Enable or Write Enable are ignored by the memory and do not affect bus operations.

3.1 Bus Read

Bus Read operations read from the memory cells, or specific registers in the Command Interface. A valid Bus Read operation involves setting the desired address on the Address Inputs, applying a Low signal, V_{IL} , to Chip Enable and Output Enable and keeping Write Enable High, V_{IH} . The Data Inputs/Outputs will output the value, see *Figure 9: Read Mode AC Waveforms*, and *Table 12: Read AC Characteristics*, for details of when the output becomes valid.

3.2 Bus Write

Bus Write operations write to the Command Interface. A valid Bus Write operation begins by setting the desired address on the Address Inputs. The Address Inputs are latched by the Command Interface on the falling edge of Chip Enable or Write Enable, whichever occurs last. The Data Inputs/Outputs are latched by the Command Interface on the rising edge of Chip Enable or Write Enable, whichever occurs first. Output Enable must remain High, V_{IH}, during the whole Bus Write operation. See *Figure 10* and *Figure 11*, Write AC waveforms, and *Table 13* and *Table 14*, Write AC Characteristics, for details of the timing requirements.

3.3 Output Disable

The Data Inputs/Outputs are in the high impedance state when Output Enable is High, VIH.

3.4 Standby

When Chip Enable is High, V_{IH} , the memory enters Standby mode and the Data Inputs/Outputs pins are placed in the high-impedance state. To reduce the Supply Current to the Standby Supply Current, I_{CC2} , Chip Enable should be held within $V_{CC} \pm 0.2V$. For the Standby current level see *Table 11: DC Characteristics*.

During program or erase operations the memory will continue to use the Program/Erase Supply Current, I_{CC3} , for Program or Erase operations until the operation completes.

3.5 Automatic Standby

If CMOS levels ($V_{CC} \pm 0.2V$) are used to drive the bus and the bus is inactive for 300ns or more the memory enters Automatic Standby where the internal Supply Current is reduced to the Standby Supply Current, I_{CC2}. The Data Inputs/Outputs will still output data if a Bus Read operation is in progress.



3.6 Special bus operations

Additional bus operations can be performed to read the Electronic Signature and also to apply and remove Block Protection. These bus operations are intended for use by programming equipment and are not usually used in applications. They require V_{ID} to be applied to some pins.

3.6.1 Electronic Signature

The memory has two codes, the manufacturer code and the device code, that can be read to identify the memory. These codes can be read by applying the signals listed in *Table 2* and *Table 3*, Bus Operations.

3.6.2 Block Protect and Chip Unprotect

Each block can be separately protected against accidental Program or Erase. The whole chip can be unprotected to allow the data inside the blocks to be changed.

Block Protect and Chip Unprotect operations are described in Appendix C: Block Protection.

Operation	Ē	G	w	Address Inputs	Data Inputs/Outputs			
Operation	E	G	vv	DQ15A–1, A0-A20	, A0-A20 DQ14-DQ8 DQ7-DQ0			
Bus Read	V _{IL}	V _{IL}	V_{IH}	Cell Address	Hi-Z	Data Output		
Bus Write	V _{IL}	V _{IH}	VIL	Command Address	Hi-Z	Data Input		
Output Disable	Х	V_{IH}	V_{IH}	Х	Hi-Z	Hi-Z		
Standby	V _{IH}	Х	Х	Х	Hi-Z	Hi-Z		
Read Manufacturer Code	V _{IL}	V _{IL}	V _{IH}	$\begin{array}{l} A0 = V_{IL}, A1 = V_{IL}, A9 = V_{ID}, \\ \text{Others } V_{IL} \text{ or } V_{IH} \end{array}$	Hi-Z	20h		
Read Device Code	V _{IL}	V _{IL}	V _{IH}		= V _{IL} , hers V _{IL} or V _{IH} Hi-Z CAr CBr			

Table 2.Bus Operations, $\overline{BYTE} = V_{IL}^{(1)}$

1. $X = V_{IL} \text{ or } V_{IH}.$

Table 3. Bus Operations, $\overline{\text{BYTE}} = V_{\text{IH}}^{(1)}$

Operation	Ē	G	W	Address Inputs A0-A20	Data Inputs/Outputs DQ15A-1, DQ14-DQ0
Bus Read	V _{IL}	V _{IL}	V _{IH}	Cell Address	Data Output
Bus Write	VIL	V _{IH}	VIL	Command Address	Data Input
Output Disable	Х	V _{IH}	V _{IH}	Х	Hi-Z
Standby	V _{IH}	Х	Х	Х	Hi-Z
Read Manufacturer Code	V _{IL}	V _{IL}	V _{IH}	$\begin{array}{l} A0=V_{IL},A1=V_{IL},A9=V_{ID},\\ OthersV_{IL}orV_{IH} \end{array}$	0020h
Read Device Code	V _{IL}	V _{IL}	V _{IH}	$ A0 = V_{IH}, A1 = V_{IL}, A9 = V_{ID}, \\ Others V_{IL} \text{ or } V_{IH} $	22CAh (M29W320DT) 22CBh (M29W320DB)

1. $X = V_{IL} \text{ or } V_{IH}$.



4 Command Interface

All Bus Write operations to the memory are interpreted by the Command Interface. Commands consist of one or more sequential Bus Write operations. Failure to observe a valid sequence of Bus Write operations will result in the memory returning to Read mode. The long command sequences are imposed to maximize data security.

The address used for the commands changes depending on whether the memory is in 16bit or 8-bit mode. See either *Table 4*, or *Table 5*, depending on the configuration that is being used, for a summary of the commands.

4.1 Read/Reset command

The Read/Reset command returns the memory to its Read mode where it behaves like a ROM or EPROM, unless otherwise stated. It also resets the errors in the Status Register. Either one or three Bus Write operations can be used to issue the Read/Reset command.

The Read/Reset Command can be issued, between Bus Write cycles before the start of a program or erase operation, to return the device to read mode. Once the program or erase operation has started the Read/Reset command is no longer accepted. The Read/Reset command will not abort an Erase operation when issued while in Erase Suspend.

4.2 Auto Select command

The Auto Select command is used to read the Manufacturer Code, the Device Code and the Block Protection Status. Three consecutive Bus Write operations are required to issue the Auto Select command. Once the Auto Select command is issued the memory remains in Auto Select mode until a Read/Reset command is issued. Read CFI Query and Read/Reset commands are accepted in Auto Select mode, all other commands are ignored.

From the Auto Select mode the Manufacturer Code can be read using a Bus Read operation with $A0 = V_{IL}$ and $A1 = V_{IL}$. The other address bits may be set to either V_{IL} or V_{IH} . The Manufacturer Code for STMicroelectronics is 0020h.

The Device Code can be read using a Bus Read operation with A0 = V_{IH} and A1 = V_{IL} . The other address bits may be set to either V_{IL} or V_{IH} . The Device Code for the M29W320DT is 22CAh and for the M29W320DB is 22CBh.

The Block Protection Status of each block can be read using a Bus Read operation with A0 = V_{IL} , A1 = V_{IH} , and A12-A20 specifying the address of the block. The other address bits may be set to either V_{IL} or V_{IH} . If the addressed block is protected then 01h is output on Data Inputs/Outputs DQ0-DQ7, otherwise 00h is output.



4.3 Read CFI Query command

The Read CFI Query Command is used to read data from the Common Flash Interface (CFI) Memory Area. This command is valid when the device is in the Read Array mode, or when the device is in Autoselected mode.

One Bus Write cycle is required to issue the Read CFI Query Command. Once the command is issued subsequent Bus Read operations read from the Common Flash Interface Memory Area.

The Read/Reset command must be issued to return the device to the previous mode (the Read Array mode or Autoselected mode). A second Read/Reset command would be needed if the device is to be put in the Read Array mode from Autoselected mode.

See Appendix B: Common Flash Interface (CFI), Table 21, Table 22, Table 23, Table 24, Table 25 and Table 26 for details on the information contained in the Common Flash Interface (CFI) memory area.

4.4 **Program command**

The Program command can be used to program a value to one address in the memory array at a time. The command requires four Bus Write operations, the final write operation latches the address and data in the internal state machine and starts the Program/Erase Controller.

If the address falls in a protected block then the Program command is ignored, the data remains unchanged. The Status Register is never read and no error condition is given.

During the program operation the memory will ignore all commands. It is not possible to issue any command to abort or pause the operation. Typical program times are given in *Table 6.* Bus Read operations during the program operation will output the Status Register on the Data Inputs/Outputs. See the section on the Status Register for more details.

After the program operation has completed the memory will return to the Read mode, unless an error has occurred. When an error occurs the memory will continue to output the Status Register. A Read/Reset command must be issued to reset the error condition and return to Read mode.

Note that the Program command cannot change a bit set at '0' back to '1'. One of the Erase Commands must be used to set all the bits in a block or in the whole memory from '0' to '1'.

4.5 Unlock Bypass command

The Unlock Bypass command is used in conjunction with the Unlock Bypass Program command to program the memory. When the cycle time to the device is long (as with some EPROM programmers) considerable time saving can be made by using these commands. Three Bus Write operations are required to issue the Unlock Bypass command.

Once the Unlock Bypass command has been issued the memory will only accept the Unlock Bypass Program command and the Unlock Bypass Reset command. The memory can be read as if in Read mode.

The memory offers accelerated program operations through the V_{PP}/Write Protect pin. When the system asserts V_{PP} on the V_{PP}/Write Protect pin, the memory automatically enters the Unlock Bypass mode. The system may then write the two-cycle Unlock Bypass

program command sequence. The memory uses the higher voltage on the V_{PP} /Write Protect pin, to accelerate the Unlock Bypass Program operation.

Never raise V_{PP} /Write Protect to V_{PP} from any mode except Read mode, otherwise the memory may be left in an indeterminate state.

4.6 Unlock Bypass Program command

The Unlock Bypass Program command can be used to program one address in the memory array at a time. The command requires two Bus Write operations, the final write operation latches the address and data in the internal state machine and starts the Program/Erase Controller.

The Program operation using the Unlock Bypass Program command behaves identically to the Program operation using the Program command. The operation cannot be aborted, the Status Register is read and protected blocks cannot be programmed. Errors must be reset using the Read/Reset command, which leaves the device in Unlock Bypass Mode. See the Program command for details on the behavior.

4.7 Unlock Bypass Reset command

The Unlock Bypass Reset command can be used to return to Read/Reset mode from Unlock Bypass Mode. Two Bus Write operations are required to issue the Unlock Bypass Reset command. Read/Reset command does not exit from Unlock Bypass Mode.

4.8 Chip Erase command

The Chip Erase command can be used to erase the entire chip. Six Bus Write operations are required to issue the Chip Erase Command and start the Program/Erase Controller.

If any blocks are protected then these are ignored and all the other blocks are erased. If all of the blocks are protected the Chip Erase operation appears to start but will terminate within about 100µs, leaving the data unchanged. No error condition is given when protected blocks are ignored.

During the erase operation the memory will ignore all commands, including the Erase Suspend command. It is not possible to issue any command to abort the operation. Typical chip erase times are given in *Table 6*. All Bus Read operations during the Chip Erase operation will output the Status Register on the Data Inputs/Outputs. See the section on the Status Register for more details.

After the Chip Erase operation has completed the memory will return to the Read Mode, unless an error has occurred. When an error occurs the memory will continue to output the Status Register. A Read/Reset command must be issued to reset the error condition and return to Read Mode.

The Chip Erase Command sets all of the bits in unprotected blocks of the memory to '1'. All previous data is lost.



4.9 Block Erase command

The Block Erase command can be used to erase a list of one or more blocks. Six Bus Write operations are required to select the first block in the list. Each additional block in the list can be selected by repeating the sixth Bus Write operation using the address of the additional block. The Block Erase operation starts the Program/Erase Controller about 50µs after the last Bus Write operation. Once the Program/Erase Controller starts it is not possible to select any more blocks. Each additional block must therefore be selected within 50µs of the last block. The 50µs timer restarts when an additional block is selected. The Status Register can be read after the sixth Bus Write operation. See the Status Register section for details on how to identify if the Program/Erase Controller has started the Block Erase operation.

If any selected blocks are protected then these are ignored and all the other selected blocks are erased. If all of the selected blocks are protected the Block Erase operation appears to start but will terminate within about 100μ s, leaving the data unchanged. No error condition is given when protected blocks are ignored.

During the Block Erase operation the memory will ignore all commands except the Erase Suspend command. Typical block erase times are given in *Table 6*. All Bus Read operations during the Block Erase operation will output the Status Register on the Data Inputs/Outputs. See the section on the Status Register for more details.

After the Block Erase operation has completed the memory will return to the Read Mode, unless an error has occurred. When an error occurs the memory will continue to output the Status Register. A Read/Reset command must be issued to reset the error condition and return to Read mode.

The Block Erase Command sets all of the bits in the unprotected selected blocks to '1'. All previous data in the selected blocks is lost.

4.10 Erase Suspend command

The Erase Suspend Command may be used to temporarily suspend a Block Erase operation and return the memory to Read mode. The command requires one Bus Write operation.

The Program/Erase Controller will suspend within the Erase Suspend Latency Time (refer to *Table 6* for value) of the Erase Suspend Command being issued. Once the Program/Erase Controller has stopped the memory will be set to Read mode and the Erase will be suspended. If the Erase Suspend command is issued during the period when the memory is waiting for an additional block (before the Program/Erase Controller starts) then the Erase is suspended immediately and will start immediately when the Erase Resume Command is issued. It is not possible to select any further blocks to erase after the Erase Resume.

During Erase Suspend it is possible to Read and Program cells in blocks that are not being erased; both Read and Program operations behave as normal on these blocks. If any attempt is made to program in a protected block or in the suspended block then the Program command is ignored and the data remains unchanged. The Status Register is not read and no error condition is given. Reading from blocks that are being erased will output the Status Register.

It is also possible to issue the Auto Select, Read CFI Query and Unlock Bypass commands during an Erase Suspend. The Read/Reset command must be issued to return the device to Read Array mode before the Resume command will be accepted.



4.11 Erase Resume command

The Erase Resume command must be used to restart the Program/Erase Controller after an Erase Suspend. The device must be in Read Array mode before the Resume command will be accepted. An erase can be suspended and resumed more than once.

4.12 Block Protect and Chip Unprotect commands

Each block can be separately protected against accidental Program or Erase. The whole chip can be unprotected to allow the data inside the blocks to be changed.

Block Protect and Chip Unprotect operations are described in Appendix C: Block Protection.



Table 4. Comman	ius,	$\mathbf{10^{-} bit mode, BTTE = \mathbf{V}_{\text{IH}}^{+} \times \mathbf{V}_{\text{IH}}^{+} $											
	_		Bus Write Operations										
Command	Length	1	1st		2nd		3rd		4th		5th		h
		Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data
Read/Reset ⁽³⁾	1	Х	F0										
neau/neset	3	555	AA	2AA	55	Х	F0						
Auto Select ⁽⁴⁾	3	555	AA	2AA	55	555	90						
Program ⁽⁵⁾	4	555	AA	2AA	55	555	A0	PA	PD				
Unlock Bypass ⁽⁶⁾	3	555	AA	2AA	55	555	20						
Unlock Bypass Program ⁽⁵⁾	2	х	A0	PA	PD								
Unlock Bypass Reset ⁽⁷⁾	2	х	90	х	00								
Chip Erase ⁽⁵⁾	6	555	AA	2AA	55	555	80	555	AA	2AA	55	555	10
Block Erase ⁽⁵⁾	6+	555	AA	2AA	55	555	80	555	AA	2AA	55	BA	30
Erase Suspend ⁽⁸⁾	1	Х	B0										
Erase Resume ⁽⁹⁾	1	Х	30										
Read CFI Query ⁽¹⁰⁾	1	55	98										

Table 4. Commands, 16-bit mode, $\overline{\text{BYTE}} = V_{\text{IH}}^{(1)(2)}$

1. X Don't Care, PA Program Address, PD Program Data, BA Any address in the Block. All values in the table are in hexadecimal.

The Command Interface only uses A–1, <u>A0-A</u>10 and DQ0-DQ7 to verify the commands; A11-A20, DQ8-DQ14 and DQ15 are Don't Care. DQ15A–1 is A–1 when BYTE is V_{IL} or DQ15 when BYTE is V_{IH}.

3. After a Read/Reset command, read the memory as normal until another command is issued. Read/Reset command is ignored during algorithm execution.

- 4. After an Auto Select command, read Manufacturer ID, Device ID or Block Protection Status.
- After Program, Unlock Bypass Program, Chip Erase, Block Erase commands read the Status Register until the Program/Erase Controller completes and the memory returns to Read Mode. Add additional Blocks during Block Erase Command with additional Bus Write Operations until Timeout Bit is set.
- 6. After the Unlock Bypass command issue Unlock Bypass Program or Unlock Bypass Reset commands.
- 7. After the Unlock Bypass Reset command read the memory as normal until another command is issued.
- 8. After the Erase Suspend command read non-erasing memory blocks as normal, issue Auto Select and Program

commands on non-erasing blocks as normal.
9. After the Erase Resume command the suspended Erase operation resumes, read the Status Register until the Program/Erase Controller completes and the memory returns to Read Mode.

10. CFI Query command is valid when device is ready to read array data or when device is in autoselected mode.



			,		• IL	Bue	Write	Oneret	lana				
	ء		Bus Write Operations										
Command	Length	1:	1st		2nd		3rd		4th		5th		th
		Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data
Read/Reset ⁽³⁾	1	Х	F0										
	3	AAA	AA	555	55	Х	F0						
Auto Select ⁽⁴⁾	3	AAA	AA	555	55	AAA	90						
Program ⁽⁵⁾	4	AAA	AA	555	55	AAA	A0	PA	PD				
Unlock Bypass ⁽⁶⁾	3	AAA	AA	555	55	AAA	20						
Unlock Bypass Program ⁽⁵⁾	2	х	A0	PA	PD								
Unlock Bypass Reset ⁽⁷⁾	2	х	90	х	00								
Chip Erase ⁽⁵⁾	6	AAA	AA	555	55	AAA	80	AAA	AA	555	55	AAA	10
Block Erase ⁽⁵⁾	6+	AAA	AA	555	55	AAA	80	AAA	AA	555	55	BA	30
Erase Suspend ⁽⁸⁾	1	Х	B0										
Erase Resume ⁽⁹⁾	1	Х	30										
Read CFI Query ⁽¹⁰⁾	1	AA	98										

Table 5. Commands, 8-bit mode, $\overline{BYTE} = V_{II}^{(1)(2)}$

1. X Don't Care, PA Program Address, PD Program Data, BA Any address in the Block. All values in the table are in hexadecimal.

The Command Interface only uses A–1, <u>A0-A</u>10 and DQ0-DQ7 to verify the commands; A11-A20, DQ8-DQ14 and DQ15 are Don't Care. DQ15A–1 is A–1 when BYTE is V_{IL} or DQ15 when BYTE is V_{IH}.

- 3. After a Read/Reset command, read the memory as normal until another command is issued. Read/Reset command is ignored during algorithm execution.
- 4. After an Auto Select command, read Manufacturer ID, Device ID or Block Protection Status.
- After a Program, Unlock Bypass Program, Chip Erase, Block Erase command read the Status Register until the Program/Erase Controller completes and the memory returns to Read Mode. Add additional Blocks during Block Erase Command with additional Bus Write Operations until Timeout Bit is set.
- 6. After the Unlock Bypass command issue Unlock Bypass Program or Unlock Bypass Reset commands.
- 7. After the Unlock Bypass Reset command read the memory as normal until another command is issued.
- 8. After the Erase Suspend command read non-erasing memory blocks as normal, issue Auto Select and Program commands on non-erasing blocks as normal.
- 9. After the Erase Resume command the suspended Erase operation resumes, read the Status Register until the Program/Erase Controller completes and the memory returns to Read Mode.
- 10. The CFI Query command is valid when device is ready to read array data or when device is in autoselected mode.



Parameter	Min	Typ ⁽¹⁾⁽²⁾	Max ⁽²⁾	Unit
Chip Erase		40	200 ⁽³⁾	S
Block Erase (64 KBytes)		0.8	6 ⁽⁴⁾	s
Erase Suspend Latency Time		15	25 ⁽⁴⁾	μs
Program (Byte or Word)		10	200 ⁽³⁾	μs
Accelerated Program (Byte or Word)		8	150 ⁽³⁾	μs
Chip Program (Byte by Byte)		40	200 ⁽³⁾	S
Chip Program (Word by Word)		20	100 ⁽³⁾	S
Program/Erase Cycles (per Block)	100,000			cycles
Data Retention	20			years

Table 6. Program, Erase Times and Program, Erase Endurance Cycles

1. Typical values measured at room temperature and nominal voltages.

2. Sampled, but not 100% tested.

3. Maximum value measured at worst case conditions for both temperature and V_{CC} after 100,00 program/erase cycles.

4. Maximum value measured at worst case conditions for both temperature and $\mathrm{V}_{\mathrm{CC}}.$



5 Status Register

Bus Read operations from any address always read the Status Register during Program and Erase operations. It is also read during Erase Suspend when an address within a block being erased is accessed.

The bits in the Status Register are summarized in Table 7: Status Register Bits.

5.1 Data Polling Bit (DQ7)

The Data Polling Bit can be used to identify whether the Program/Erase Controller has successfully completed its operation or if it has responded to an Erase Suspend. The Data Polling Bit is output on DQ7 when the Status Register is read.

During Program operations the Data Polling Bit outputs the complement of the bit being programmed to DQ7. After successful completion of the Program operation the memory returns to Read mode and Bus Read operations from the address just programmed output DQ7, not its complement.

During Erase operations the Data Polling Bit outputs '0', the complement of the erased state of DQ7. After successful completion of the Erase operation the memory returns to Read Mode.

In Erase Suspend mode the Data Polling Bit will output a '1' during a Bus Read operation within a block being erased. The Data Polling Bit will change from a '0' to a '1' when the Program/Erase Controller has suspended the Erase operation.

Figure 6: Data Polling Flowchart, gives an example of how to use the Data Polling Bit. A Valid Address is the address being programmed or an address within the block being erased.

5.2 Toggle Bit (DQ6)

The Toggle Bit can be used to identify whether the Program/Erase Controller has successfully completed its operation or if it has responded to an Erase Suspend. The Toggle Bit is output on DQ6 when the Status Register is read.

During Program and Erase operations the Toggle Bit changes from '0' to '1' to '0', etc., with successive Bus Read operations at any address. After successful completion of the operation the memory returns to Read mode.

During Erase Suspend mode the Toggle Bit will output when addressing a cell within a block being erased. The Toggle Bit will stop toggling when the Program/Erase Controller has suspended the Erase operation.

If any attempt is made to erase a protected block, the operation is aborted, no error is signalled and DQ6 toggles for approximately 100 μ s. If any attempt is made to program a protected block or a suspended block, the operation is aborted, no error is signalled and DQ6 toggles for approximately 1 μ s.

Figure 7: Data Toggle Flowchart, gives an example of how to use the Data Toggle Bit.



5.3 Error Bit (DQ5)

The Error Bit can be used to identify errors detected by the Program/Erase Controller. The Error Bit is set to '1' when a Program, Block Erase or Chip Erase operation fails to write the correct data to the memory. If the Error Bit is set a Read/Reset command must be issued before other commands are issued. The Error bit is output on DQ5 when the Status Register is read.

Note that the Program command cannot change a bit set to '0' back to '1' and attempting to do so will set DQ5 to '1'. A Bus Read operation to that address will show the bit is still '0'. One of the Erase commands must be used to set all the bits in a block or in the whole memory from '0' to '1'.

5.4 Erase Timer Bit (DQ3)

The Erase Timer Bit can be used to identify the start of Program/Erase Controller operation during a Block Erase command. Once the Program/Erase Controller starts erasing the Erase Timer Bit is set to '1'. Before the Program/Erase Controller starts the Erase Timer Bit is set to '0' and additional blocks to be erased may be written to the Command Interface. The Erase Timer Bit is output on DQ3 when the Status Register is read.

5.5 Alternative Toggle Bit (DQ2)

The Alternative Toggle Bit can be used to monitor the Program/Erase controller during Erase operations. The Alternative Toggle Bit is output on DQ2 when the Status Register is read.

During Chip Erase and Block Erase operations the Toggle Bit changes from '0' to '1' to '0', etc., with successive Bus Read operations from addresses within the blocks being erased. A protected block is treated the same as a block not being erased. Once the operation completes the memory returns to Read mode.

During Erase Suspend the Alternative Toggle Bit changes from '0' to '1' to '0', etc. with successive Bus Read operations from addresses within the blocks being erased. Bus Read operations to addresses within blocks not being erased will output the memory cell data as if in Read mode.

After an Erase operation that causes the Error Bit to be set the Alternative Toggle Bit can be used to identify which block or blocks have caused the error. The Alternative Toggle Bit changes from '0' to '1' to '0', etc. with successive Bus Read Operations from addresses within blocks that have not erased correctly. The Alternative Toggle Bit does not change if the addressed block has erased correctly.

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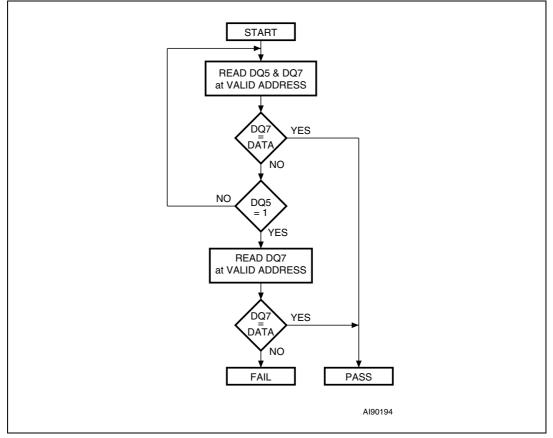


Operation	Address	DQ7	DQ6	DQ5	DQ3	DQ2	RB
Program	Any Address	DQ7	Toggle	0	_	_	0
Program During Erase Suspend	Any Address	DQ7	Toggle	0	_	-	0
Program Error	Any Address	DQ7	Toggle	1	_	_	0
Chip Erase	Any Address	0	Toggle	0	1	Toggle	0
Block Erase before	Erasing Block	0	Toggle	0	0	Toggle	0
timeout	Non-Erasing Block	0	Toggle	0	0	No Toggle	0
	Erasing Block	0	Toggle	0	1	Toggle	0
Block Erase	Non-Erasing Block	0	Toggle	0	1	No Toggle	0
Eross Suspand	Erasing Block	1	No Toggle	0	_	Toggle	1
Erase Suspend	Non-Erasing Block		•	1			
	Good Block Address	0	Toggle	1	1	No Toggle	0
Erase Error	Faulty Block Address	0	Toggle	1	1	Toggle	0

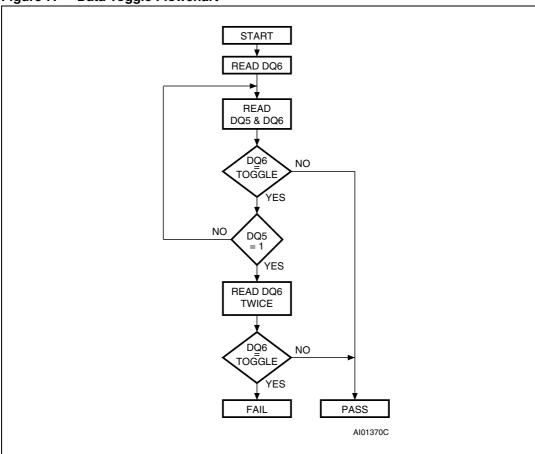
Table 7. Status Register Bits⁽¹⁾

1. Unspecified data bits should be ignored.

Figure 6. Data Polling Flowchart











6 Maximum rating

Stressing the device above the rating listed in the Absolute Maximum Ratings table may cause permanent damage to the device. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Symbol	Parameter	Min	Max	Unit
T _{BIAS}	Temperature Under Bias	-50	125	°C
T _{STG}	Storage Temperature	-65	150	°C
V _{IO}	Input or Output Voltage ⁽¹⁾⁽²⁾	-0.6	V _{CC} +0.6	V
V _{CC}	Supply Voltage	-0.6	4	V
V _{ID}	Identification Voltage	-0.6	13.5	V
V _{PP}	Program Voltage	-0.6	13.5	V

Table 8. Absolute Maximum Ratings

1. Minimum voltage may undershoot to -2V during transition and for less than 20ns during transitions.

2. Maximum voltage may overshoot to V_{CC} +2V during transition and for less than 20ns during transitions.



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7 DC and AC parameters

This section summarizes the operating measurement conditions, and the DC and AC characteristics of the device. The parameters in the DC and AC characteristics Tables that follow, are derived from tests performed under the Measurement Conditions summarized in *Table 9: Operating and AC Measurement Conditions*. Designers should check that the operating conditions in their circuit match the operating conditions when relying on the quoted parameters.

Parameter	7	0	9	Unit	
	Min	Max	Min	Max	
V _{CC} Supply Voltage	3.0	3.6	2.7	3.6	V
Ambient Operating Temperature	-40	85	-40	85	°C
Load Capacitance (C _L)	3	80	30		pF
Input Rise and Fall Times		10		10	ns
Input Pulse Voltages	0 to V _{CC}		0 to V _{CC}		V
Input and Output Timing Ref. Voltages	V _{CC} /2		V _C	V	

Table 9. Operating and AC Measurement Conditions

Figure 8. AC Measurement I/O Waveform

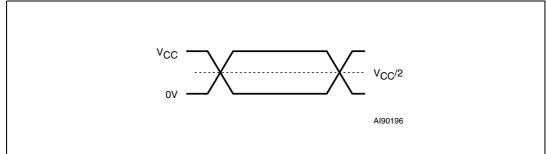


Figure 1. AC Measurement Load Circuit

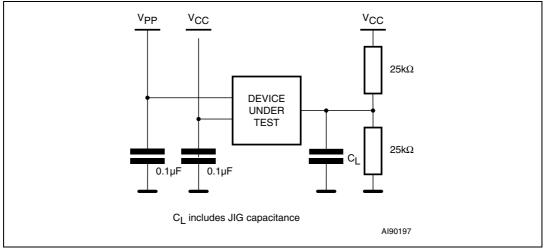


Table 10. Device Capacitance⁽¹⁾

Symbol	Parameter Test Condition		Min	Max	Unit
C _{IN}	Input Capacitance	$V_{IN} = 0V$		6	pF
C _{OUT}	Output Capacitance	V _{OUT} = 0V		12	pF



Symbol	Parameter	Test Condition		Min	Тур.	Max	Unit
Ι _{LI}	Input Leakage Current	0V ≤V _{IN} ≤V _{CC}				±1	μA
I _{LO}	Output Leakage Current	0V ≤V _{OU}	T ≤V _{CC}			±1	μA
I _{CC1}	Supply Current (Read)	Ē = V _{IL} , Ū f = 6N			5	10	mA
I _{CC2}	Supply Current (Standby)	Ē = V _{CC} RP = V _{CC}			35	100	μA
I _{CC3} ⁽¹⁾	Supply Current	Program/Eras e	V _{PP} /WP = V _{IL} or V _{IH}			20	mA
ICC3	(Program/Erase)	Controller active	V _{PP} /WP = V _{PP}			20	mA
V _{IL}	Input Low Voltage	·		-0.5		0.8	V
V _{IH}	Input High Voltage			0.7V _{CC}		V _{CC} +0.3	V
V _{PP}	Voltage for V _{PP} /WP Program Acceleration	V _{CC} = 3.0	V ±10%	11.5		12.5	V
I _{PP}	Current for V _{PP} / WP Program Acceleration	V _{CC} = 3.0	V ±10%			10	mA
V _{OL}	Output Low Voltage	I _{OL} = 1	.8mA			0.45	V
V _{OH}	Output High Voltage	I _{OH} = −100μA		V _{CC} –0.4			V
V _{ID}	Identification Voltage			11.5		12.5	V
I _{ID}	Identification Current	$A9 = V_{ID}$				100	μA
V_{LKO}	Program/Erase Lockout Supply Voltage			1.8		2.3	V

Table 11.	DC Characteristics
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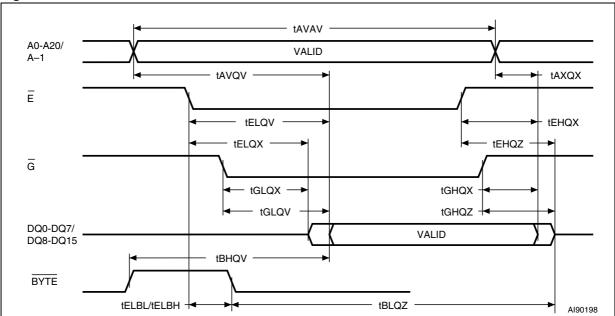


Figure 9. Read Mode AC Waveforms

Table 12. Read AC Characteristics

Symbol	Alt	Devemeter	Test Can	dition	M29W	/320D	Unit
Symbol	AIL	Parameter	Test Condition		70	90	Onit
t _{AVAV}	t _{RC}	Address Valid to Next Address Valid	$\overline{E} = V_{IL},$ $\overline{G} = V_{IL}$	Min	70	90	ns
t _{AVQV}	t _{ACC}	Address Valid to Output Valid	$\frac{\overline{E}}{\overline{G}} = V_{IL},$ $\overline{G} = V_{IL}$	Max	70	90	ns
t _{ELQX} ⁽¹⁾	t _{LZ}	Chip Enable Low to Output Transition	$\overline{G} = V_{IL}$	Min	0	0	ns
t _{ELQV}	t _{CE}	Chip Enable Low to Output Valid	$\overline{G} = V_{IL}$	Max	70	90	ns
t _{GLQX} ⁽¹⁾	t _{OLZ}	Output Enable Low to Output Transition	$\overline{E} = V_{IL}$	Min	0	0	ns
t _{GLQV}	t _{OE}	Output Enable Low to Output Valid	$\overline{E} = V_{IL}$	Max	30	35	ns
t _{EHQZ} ⁽¹⁾	t _{HZ}	Chip Enable High to Output Hi-Z	$\overline{G} = V_{IL}$	Max	25	30	ns
t _{GHQZ} ⁽¹⁾	t _{DF}	Output Enable High to Output Hi-Z	$\overline{E} = V_{IL}$	Max	25	30	ns
t _{EHQX} t _{GHQX} t _{AXQX}	t _{ОН}	Chip Enable, Output Enable or Address Transition to Output Transition		Min	0	0	ns
t _{ELBL} t _{ELBH}	t _{ELFL} t _{ELFH}	Chip Enable to BYTE Low or High		Max	5	5	ns
t _{BLQZ}	t _{FLQZ}	BYTE Low to Output Hi-Z		Max	25	30	ns
t _{BHQV}	t _{FHQV}	BYTE High to Output Valid		Max	30	40	ns



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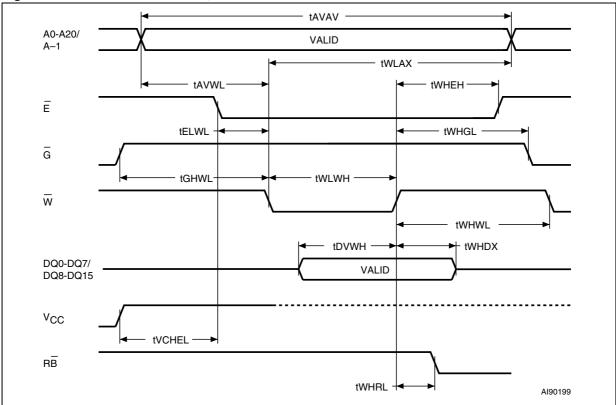
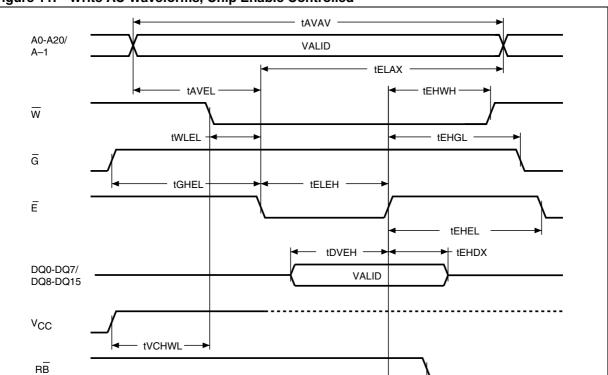


Figure 10. Write AC Waveforms, Write Enable Controlled

0h.e.l	A 14	Bananatan		M29V	/320D	11
Symbol	Alt	Parameter		70	90	Unit
t _{AVAV}	t _{WC}	Address Valid to Next Address Valid	Min	70	90	ns
t _{ELWL}	t _{CS}	Chip Enable Low to Write Enable Low	Min	0	0	ns
t _{WLWH}	t _{WP}	Write Enable Low to Write Enable High	Min	45	50	ns
t _{DVWH}	t _{DS}	Input Valid to Write Enable High	Min	45	50	ns
t _{WHDX}	t _{DH}	Write Enable High to Input Transition	Min	0	0	ns
t _{WHEH}	t _{CH}	Write Enable High to Chip Enable High	Min	0	0	ns
t _{WHWL}	t _{WPH}	Write Enable High to Write Enable Low	Min	30	30	ns
t _{AVWL}	t _{AS}	Address Valid to Write Enable Low	Min	0	0	ns
t _{WLAX}	t _{AH}	Write Enable Low to Address Transition	Min	45	50	ns
t _{GHWL}		Output Enable High to Write Enable Low	Min	0	0	ns
t _{WHGL}	t _{OEH}	Write Enable High to Output Enable Low	Min	0	0	ns
t _{WHRL} ⁽¹⁾	t _{BUSY}	Program/Erase Valid to RB Low	Max	30	35	ns
t _{VCHEL}	t _{VCS}	V _{CC} High to Chip Enable Low	Min	50	50	μs



tEHRL



Table 14.	Write AC	Characteristics, Chip Enable Controlled	I				
0h.e.l	A 14	Demonster			M29W320D		
Symbol	Alt	Parameter		70	90	Unit	
t _{AVAV}	t _{WC}	Address Valid to Next Address Valid	Min	70	90	ns	
t _{WLEL}	t _{WS}	Write Enable Low to Chip Enable Low	Min	0	0	ns	
t _{ELEH}	t _{CP}	Chip Enable Low to Chip Enable High	Min	45	50	ns	
t _{DVEH}	t _{DS}	Input Valid to Chip Enable High	Min	45	50	ns	
t _{EHDX}	t _{DH}	Chip Enable High to Input Transition	Min	0	0	ns	
t _{EHWH}	t _{WH}	Chip Enable High to Write Enable High	Min	0	0	ns	
t _{EHEL}	t _{CPH}	Chip Enable High to Chip Enable Low	Min	30	30	ns	
t _{AVEL}	t _{AS}	Address Valid to Chip Enable Low	Min	0	0	ns	
t _{ELAX}	t _{AH}	Chip Enable Low to Address Transition	Min	45	50	ns	
t _{GHEL}		Output Enable High Chip Enable Low	Min	0	0	ns	
t _{EHGL}	t _{OEH}	Chip Enable High to Output Enable Low	Min	0	0	ns	
t _{EHRL} ⁽¹⁾	t _{BUSY}	Program/Erase Valid to RB Low	Max	30	35	ns	
t _{VCHWL}	t _{VCS}	V _{CC} High to Write Enable Low	Min	50	50	μs	

1. Sampled only, not 100% tested.



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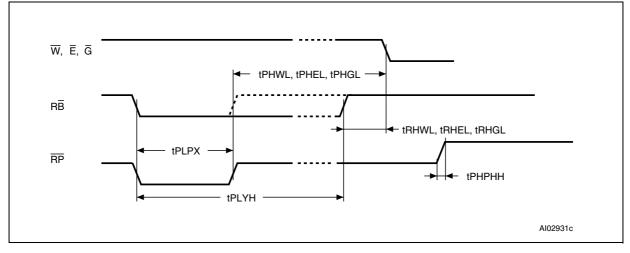


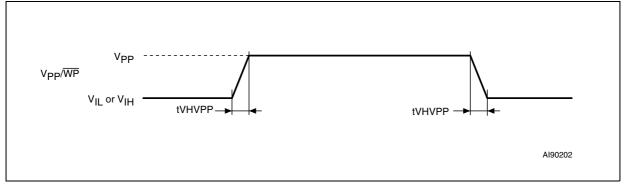
Figure 12. Reset/Block Temporary Unprotect AC Waveforms

 Table 15.
 Reset/Block Temporary Unprotect AC Characteristics

Symbol	Alt	Parameter	M29W	Unit		
Symbol	All	Falameter		70	90	Unit
t _{PHWL} ⁽¹⁾ t _{PHEL} t _{PHGL} ⁽¹⁾	t _{RH}	RP High to Write Enable Low, Chip Enable Low, Output Enable Low	Min	50	50	ns
t _{RHWL} ⁽¹⁾ t _{RHEL} ⁽¹⁾ t _{RHGL} ⁽¹⁾	t _{RB}	RB High to Write Enable Low, Chip Enable Low, Output Enable Low	Min	0	0	ns
t _{PLPX}	t _{RP}	RP Pulse Width	Min	500	500	ns
t _{PLYH} ⁽¹⁾	t _{READY}	RP Low to Read Mode	Max	25	25	μs
t _{PHPHH} ⁽¹⁾	t _{VIDR}	RP Rise Time to V _{ID}	Min	500	500	ns
t _{VHVPP} ⁽¹⁾		V _{PP} Rise and Fall Time	Min	250	250	ns

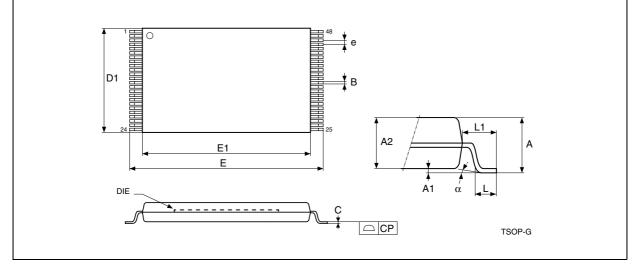
1. Sampled only, not 100% tested.

Figure 13. Accelerated Program Timing Waveforms



8 Package mechanical

Figure 14. TSOP48 Lead Plastic Thin Small Outline, 12x20 Mm, Top View Package Outline



1. Drawing not to scale.

Table 16. TSOP48 Lead Plastic Thin Small Outline, 12x20 mm, Package Mechanical Data

Cumbol	millimeters			inches		
Symbol	Тур	Min	Мах	Тур	Min	Max
А			1.200			0.0472
A1	0.100	0.050	0.150	0.0039	0.0020	0.0059
A2	1.000	0.950	1.050	0.0394	0.0374	0.0413
В	0.220	0.170	0.270	0.0087	0.0067	0.0106
С		0.100	0.210		0.0039	0.0083
CP			0.080			0.0031
D1	12.000	11.900	12.100	0.4724	0.4685	0.4764
E	20.000	19.800	20.200	0.7874	0.7795	0.7953
E1	18.400	18.300	18.500	0.7244	0.7205	0.7283
е	0.500	-	-	0.0197	-	-
L	0.600	0.500	0.700	0.0236	0.0197	0.0276
L1	0.800			0.0315		
а	3	0	5	3	0	5

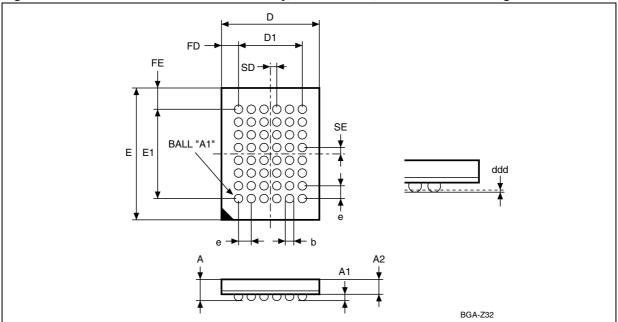


Figure 15. TFBGA48 6x8mm - 6x8 Ball Array, 0.8mm Pitch, Bottom View Package Outline

1. Drawing not to scale.

Table 17. TFBGA48 6x8mm - 6x8 Ball Array, 0.8mm Pitch, Package Mechanical Data

Symbol	millimeters			inches		
Symbol	Тур	Min	Max	Тур	Min	Мах
А			1.200			0.0472
A1		0.260			0.0102	
A2			0.900			0.0354
b		0.350	0.450		0.0138	0.0177
D	6.000	5.900	6.100	0.2362	0.2323	0.2402
D1	4.000	-	_	0.1575	_	-
ddd			0.100			0.0039
E	8.000	7.900	8.100	0.3150	0.3110	0.3189
E1	5.600	-	_	0.2205	_	-
е	0.800	-	_	0.0315	_	_
FD	1.000	-	_	0.0394	_	_
FE	1.200	-	_	0.0472	_	-
SD	0.400	-	_	0.0157	_	-
SE	0.400	-	_	0.0157	_	-

Part numbering 9

Table 18. **Ordering Information Scheme**

Example:	M29W320DB	90 N 1 T
Device Type		
M29		
Operating Voltage		
$W = V_{CC} = 2.7$ to 3.6V		
Device Function		
320D = 32 Mbit (x8/x16), Non-Uniform Parameter Blocks,		
Boot Block		
A		
Array Matrix		
T = Top Boot		
B = Bottom Boot		
Speed		
70 = 70 ns		
90 = 90 ns		
Package		
N = TSOP48: 12 x 20 mm		
ZE = TFBGA48: 6 x 8mm, 0.8mm pitch		
Temperature Range		
1 = 0 to 70 °C		
6 = -40 to 85 °C		
Option		

Blank = Standard Packing

T = Tape & Reel Packing

E = ECOPACK Package, Standard Packing

F = ECOPACK Package, Tape & Reel Packing

Devices are shipped from the factory with the memory content bits erased to '1'.

For a list of available options (Speed, Package, etc...) or for further information on any aspect of this device, please contact the ST Sales Office nearest to you.



Appendix A Block Addresses

		BIOCK Addresses, M29W320D1	
#	Size (KByte/KWor d)	Address Range (x8)	Address Range (x16)
66	16/8	3FC000h-3FFFFFh	1FE000h-1FFFFFh
65	8/4	3FA000h-3FBFFFh	1FD000h-1FDFFFh
64	8/4	3F8000h-3F9FFFh	1FC000h-1FCFFFh
63	32/16	3F0000h-3F7FFFh	1F8000h-1FBFFFh
62	64/32	3E0000h-3EFFFFh	1F0000h-1F7FFFh
61	64/32	3D0000h-3DFFFFh	1E8000h-1EFFFFh
60	64/32	3C0000h-3CFFFFh	1E0000h-1E7FFFh
59	64/32	3B0000h-3BFFFFh	1D8000h-1DFFFFh
58	64/32	3A0000h-3AFFFFh	1D0000h-1D7FFFh
57	64/32	390000h-39FFFFh	1C8000h-1CFFFFh
56	64/32	380000h-18FFFFh	1C0000h-1C7FFFh
55	64/32	370000h-37FFFFh	1B8000h-1BFFFFh
54	64/32	360000h-36FFFFh	1B0000h-1B7FFFh
53	64/32	350000h-35FFFFh	1A8000h-1AFFFFh
52	64/32	340000h-34FFFFh	1A0000h-1A7FFFh
51	64/32	330000h-33FFFFh	198000h-19FFFFh
50	64/32	320000h-32FFFFh	190000h-197FFFh
49	64/32	310000h-31FFFFh	188000h-18FFFFh
48	64/32	300000h-30FFFFh	180000h-187FFFh
47	64/32	2F0000h-2FFFFFh	178000h-17FFFFh
46	64/32	2E0000h-2EFFFFh	170000h-177FFFh
45	64/32	2D0000h-2DFFFFh	168000h-16FFFFh
44	64/32	2C0000h-2CFFFFh	160000h-167FFFh
43	64/32	2B0000h-2BFFFFh	158000h-15FFFFh
42	64/32	2A0000h-2AFFFFh	150000h-157FFFh
41	64/32	290000h-29FFFFh	148000h-14FFFFh
40	64/32	280000h-28FFFFh	140000h-147FFFh
39	64/32	270000h-27FFFFh	138000h-13FFFFh
38	64/32	260000h-26FFFFh	130000h-137FFFh
37	64/32	250000h-25FFFFh	128000h-12FFFFh
36	64/32	240000h-24FFFFh	120000h-127FFFh

Table 19. Top Boot Block Addresses, M29W320DT



Table 19.	. Top Boot Block Addresses, M29W320DT (continued)				
35	64/32	230000h-23FFFFh	118000h-11FFFFh		
34	64/32	220000h-22FFFFh	110000h-117FFFh		
33	64/32	210000h-21FFFFh	108000h-10FFFFh		
32	64/32	200000h-20FFFFh	100000h-107FFFh		
31	64/32	1F0000h-1FFFFFh	0F8000h-0FBFFFh		
30	64/32	1E0000h-1EFFFFh	0F0000h-0F7FFFh		
29	64/32	1D0000h-1DFFFFh	0E8000h-0EFFFFh		
28	64/32	1C0000h-1CFFFFh	0E0000h-0E7FFFh		
27	64/32	1B0000h-1BFFFFh	0D8000h-0DFFFFh		
26	64/32	1A0000h-1AFFFFh	0D0000h-0D7FFFh		
25	64/32	190000h-19FFFFh	0C8000h-0CFFFFh		
24	64/32	180000h-18FFFFh	0C0000h-0C7FFFh		
23	64/32	170000h-17FFFFh	0B8000h-0BFFFFh		
22	64/32	160000h-16FFFFh	0B0000h-0B7FFFh		
21	64/32	150000h-15FFFFh	0A8000h-0AFFFh		
20	64/32	140000h-14FFFFh	0A0000h-0A7FFFh		
19	64/32	130000h-13FFFFh	098000h-09FFFFh		
18	64/32	120000h-12FFFFh	090000h-097FFFh		
17	64/32	110000h-11FFFFh	088000h-08FFFFh		
16	64/32	100000h-10FFFFh	080000h-087FFFh		
15	64/32	0F0000h-0FFFFFh	078000h-07FFFFh		
14	64/32	0E0000h-0EFFFFh	070000h-077FFFh		
13	64/32	0D0000h-0DFFFFh	068000h-06FFFFh		
12	64/32	0C0000h-0CFFFFh	060000h-067FFFh		
11	64/32	0B0000h-0BFFFFh	058000h-05FFFFh		
10	64/32	0A0000h-0AFFFFh	050000h-057FFFh		
9	64/32	090000h-09FFFFh	048000h-04FFFFh		
8	64/32	080000h-08FFFFh	040000h-047FFFh		
7	64/32	070000h-07FFFFh	038000h-03FFFFh		
6	64/32	060000h-06FFFFh	030000h-037FFFh		
5	64/32	050000h-05FFFFh	028000h-02FFFFh		
4	64/32	040000h-04FFFFh	020000h-027FFFh		
3	64/32	030000h-03FFFFh	018000h-01FFFFh		
2	64/32	020000h-02FFFFh	010000h-017FFFh		
1	64/32	010000h-01FFFFh	008000h-00FFFFh		
0	64/32	000000h-00FFFFh	000000h-007FFFh		

 Table 19.
 Top Boot Block Addresses, M29W320DT (continued)



Table 20. Bottom Boot Block Addresses, M29W320DB					
#	Size (KByte/KWord)	Address Range (x8)	Address Range (x16)		
66	64/32	3F0000h-3FFFFFh	1F8000h-1FFFFFh		
65	64/32	3E0000h-3EFFFFh	1F0000h-1F7FFFh		
64	64/32	3D0000h-3DFFFFh	1E8000h-1EFFFFh		
63	64/32	3C0000h-3CFFFFh	1E0000h-1E7FFFh		
62	64/32	3B0000h-3BFFFFh	1D8000h-1DFFFFh		
61	64/32	3A0000h-3AFFFFh	1D0000h-1D7FFFh		
60	64/32	390000h-39FFFFh	1C8000h-1CFFFFh		
59	64/32	380000h-18FFFFh	1C0000h-1C7FFFh		
58	64/32	370000h-37FFFFh	1B8000h-1BFFFFh		
57	64/32	360000h-36FFFFh	1B0000h-1B7FFFh		
56	64/32	350000h-35FFFFh	1A8000h-1AFFFFh		
55	64/32	340000h-34FFFFh	1A0000h-1A7FFFh		
54	64/32	330000h-33FFFFh	198000h-19FFFFh		
53	64/32	320000h-32FFFFh	190000h-197FFFh		
52	64/32	310000h-31FFFFh	188000h-18FFFFh		
51	64/32	300000h-30FFFFh	180000h-187FFFh		
50	64/32	2F0000h-2FFFFFh	178000h-17FFFFh		
49	64/32	2E0000h-2EFFFFh	170000h-177FFFh		
48	64/32	2D0000h-2DFFFFh	168000h-16FFFFh		
47	64/32	2C0000h-2CFFFFh	160000h-167FFFh		
46	64/32	2B0000h-2BFFFFh	158000h-15FFFFh		
45	64/32	2A0000h-2AFFFFh	150000h-157FFFh		
44	64/32	290000h-29FFFFh	148000h-14FFFFh		
43	64/32	280000h-28FFFFh	140000h-147FFFh		
42	64/32	270000h-27FFFFh	138000h-13FFFFh		
41	64/32	260000h-26FFFFh	130000h-137FFFh		
40	64/32	250000h-25FFFFh	128000h-12FFFFh		
39	64/32	240000h-24FFFFh	120000h-127FFFh		
38	64/32	230000h-23FFFFh	118000h-11FFFFh		
37	64/32	220000h-22FFFFh	110000h-117FFFh		
36	64/32	210000h-21FFFFh	108000h-10FFFFh		
35	64/32	200000h-20FFFFh	100000h-107FFFh		
34	64/32	1F0000h-1FFFFFh	0F8000h-0FBFFFh		
33	64/32	1E0000h-1EFFFFh	0F0000h-0F7FFFh		

Table 20. Bottom Boot Block Addresses, M29W320DB



32 64/32 1D000h-1DFFFh 0E8000h-0EFFFh 31 64/32 1C000h-1CFFFh 0E000h-0E7FFh 30 64/32 1B000h-1BFFFh 0D800h-0DFFFh 29 64/32 1A000h-1AFFFFh 0D000h-0D7FFFh 28 64/32 19000h-1BFFFh 0C8000h-0CFFFFh 27 64/32 18000h-1FFFFh 0C8000h-0CFFFFh 26 64/32 17000h-1FFFFh 0B8000h-0BFFFFh 26 64/32 15000h-1FFFFh 0B8000h-0BFFFFh 24 64/32 15000h-1FFFFh 0B8000h-0AFFFFh 23 64/32 13000h-1FFFFh 0A8000h-0AFFFFh 24 64/32 13000h-1FFFFh 0A8000h-0AFFFFh 27 64/32 13000h-1FFFFh 0A8000h-0AFFFFh 28 64/32 13000h-1FFFFh 0A8000h-0AFFFFh 29 64/32 10000h-1FFFFh 0A8000h-0BFFFFh 20 64/32 10000h-1FFFFh 088000h-0BFFFFh 19 64/32 0F000h-0FFFFFh 078000h-0FFFFh 18	Table 20. Bottom Boot Block Addresses, M29W320DB (continued)					
30 64/32 1B000h-1BFFFh 0D800h-0DFFFFh 29 64/32 1A000h-1AFFFFh 0D000h-0D7FFFh 28 64/32 19000h-19FFFh 0C8000h-0CFFFFh 27 64/32 18000h-18FFFFh 0C0000h-0CFFFFh 26 64/32 170000h-17FFFFh 0B8000h-0BFFFFh 25 64/32 160000h-16FFFFh 0B0000h-0B7FFFh 24 64/32 150000h-13FFFFh 0A8000h-0AFFFFh 23 64/32 130000h-13FFFFh 098000h-0AFFFFh 23 64/32 130000h-13FFFFh 098000h-09FFFFh 21 64/32 120000h-12FFFFh 098000h-08FFFFh 20 64/32 10000h-11FFFFh 098000h-08FFFFh 20 64/32 10000h-01FFFFh 088000h-08FFFFh 19 64/32 0F0000h-0FFFFFh 078000h-07FFFFh 16 64/32 0D0000h-0DFFFFFh 078000h-06FFFFh 16 64/32 0D000h-0AFFFFh 068000h-06FFFFh 15 64/32 0D0000h-0FFFFFh 068000h-06FFFFh <t< th=""><th>32</th><th>64/32</th><th>1D0000h-1DFFFFh</th><th>0E8000h-0EFFFFh</th></t<>	32	64/32	1D0000h-1DFFFFh	0E8000h-0EFFFFh		
29 64/32 1A0000h-1AFFFFh 0D0000h-0D7FFFh 28 64/32 190000h-19FFFFh 0C8000h-0C7FFFh 27 64/32 170000h-17FFFFh 0B8000h-0B7FFFh 26 64/32 170000h-17FFFFh 0B8000h-0B7FFFh 25 64/32 150000h-16FFFFh 0A8000h-0A7FFFh 24 64/32 150000h-13FFFFh 0A8000h-0A7FFFh 23 64/32 13000h-13FFFFh 098000h-09FFFFh 21 64/32 12000h-12FFFFh 098000h-09FFFFh 20 64/32 10000h-10FFFFh 098000h-087FFFh 19 64/32 10000h-10FFFFh 088000h-08FFFFh 19 64/32 0F000h-0FFFFFh 078000h-07FFFh 18 64/32 0F0000h-0EFFFFh 078000h-07FFFh 17 64/32 0E0000h-0EFFFFh 078000h-06FFFFh 18 64/32 0E0000h-0EFFFFh 068000h-06FFFFh 14 64/32 0B0000h-08FFFFh 058000h-05FFFFh 14 64/32 0B0000h-08FFFFh 048000h-04FFFFh	31	64/32	1C0000h-1CFFFFh	0E0000h-0E7FFFh		
28 64/32 19000h-19FFFh 0C8000h-0CFFFFh 27 64/32 18000h-18FFFh 0C0000h-0C7FFFh 26 64/32 17000h-17FFFFh 0B8000h-0B7FFFh 25 64/32 16000h-16FFFFh 0B8000h-0B7FFFh 24 64/32 15000h-15FFFFh 0A8000h-0A7FFFh 23 64/32 13000h-13FFFFh 0A8000h-0A7FFFh 22 64/32 13000h-13FFFFh 09800h-09FFFh 21 64/32 12000h-12FFFh 09800h-09FFFh 20 64/32 12000h-12FFFh 09800h-08FFFh 19 64/32 10000h-10FFFFh 088000h-08FFFh 18 64/32 0F000h-0FFFFh 07800h-07FFFh 17 64/32 0E000h-0EFFFh 07800h-07FFFh 18 64/32 0D000h-0DFFFFh 06800h-06FFFFh 15 64/32 0D000h-0FFFFh 06800h-06FFFFh 14 64/32 0D000h-0FFFFh 05800h-05FFFh 13 64/32 0A000h-08FFFFh 038000h-03FFFFh 14	30	64/32	1B0000h-1BFFFFh	0D8000h-0DFFFFh		
27 64/32 18000h-18FFFFh 0C0000h-0C7FFFh 26 64/32 17000h-17FFFFh 0B8000h-0BFFFFh 25 64/32 16000h-16FFFFh 0B8000h-0B7FFFh 24 64/32 15000h-16FFFFh 0A8000h-0AFFFFh 23 64/32 14000h-14FFFFh 0A8000h-0AFFFFh 24 64/32 13000h-13FFFFh 098000h-09FFFFh 21 64/32 12000h-12FFFFh 098000h-09FFFFh 20 64/32 11000h-11FFFFh 088000h-08FFFFh 19 64/32 10000h-10FFFFh 088000h-08FFFFh 19 64/32 0F000h-0FFFFh 07800h-07FFFFh 17 64/32 0E000h-0EFFFFh 07800h-07FFFFh 18 64/32 0D000h-0DFFFFh 068000h-06FFFFh 16 64/32 0D000h-0FFFFh 068000h-06FFFFh 14 64/32 0D000h-0FFFFh 05800h-05FFFh 13 64/32 0A000h-0AFFFFh 05800h-05FFFh 14 64/32 03000h-03FFFFh 048000h-04FFFFh	29	64/32	1A0000h-1AFFFFh	0D0000h-0D7FFFh		
26 64/32 170000h-17FFFh 0B8000h-0BFFFh 25 64/32 160000h-16FFFh 0B0000h-0B7FFFh 24 64/32 150000h-15FFFh 0A8000h-0AFFFFh 23 64/32 140000h-14FFFFh 0A0000h-0A7FFFh 22 64/32 130000h-13FFFFh 098000h-09FFFFh 21 64/32 120000h-12FFFFh 090000h-09FFFFh 20 64/32 110000h-11FFFFh 098000h-08FFFFh 20 64/32 10000h-10FFFFh 098000h-08FFFFh 19 64/32 10000h-10FFFFh 08000h-08FFFFh 18 64/32 0F000h-0FFFFh 078000h-07FFFh 16 64/32 0F000h-0EFFFFh 078000h-07FFFh 16 64/32 0D000h-0DFFFFh 068000h-06FFFFh 16 64/32 0D000h-0AFFFFh 068000h-06FFFFh 14 64/32 0B000h-0AFFFFh 058000h-05FFFh 13 64/32 0A000h-0AFFFFh 058000h-03FFFFh 14 64/32 070000h-03FFFFh 048000h-04FFFFh	28	64/32	190000h-19FFFFh	0C8000h-0CFFFFh		
25 64/32 160000h-16FFFh 0B0000h-087FFFh 24 64/32 150000h-15FFFh 0A8000h-0AFFFFh 23 64/32 14000h-14FFFh 0A0000h-0AFFFFh 22 64/32 130000h-13FFFFh 098000h-09FFFh 21 64/32 12000h-12FFFh 098000h-09FFFh 20 64/32 110000h-11FFFFh 098000h-08FFFh 19 64/32 10000h-10FFFFh 08000h-08FFFh 19 64/32 10000h-10FFFFh 08000h-08FFFh 18 64/32 0F000h-0FFFFh 07800h-07FFFh 16 64/32 0F000h-0FFFFh 07800h-07FFFh 16 64/32 0D000h-0FFFFh 07800h-07FFFh 16 64/32 0D000h-0FFFFh 06800h-06FFFFh 16 64/32 0D000h-0FFFFh 06800h-06FFFFh 13 64/32 0C000h-0FFFFh 05800h-05FFFh 14 64/32 0B000h-08FFFFh 05800h-03FFFFh 13 64/32 07000h-07FFFFh 038000h-03FFFFh 14	27	64/32	180000h-18FFFFh	0C0000h-0C7FFFh		
24 64/32 150000h-15FFFFh 0A8000h-0AFFFFh 23 64/32 140000h-14FFFFh 0A0000h-0AFFFFh 22 64/32 130000h-13FFFFh 098000h-09FFFFh 21 64/32 120000h-12FFFFh 099000h-09FFFFh 20 64/32 110000h-11FFFFh 098000h-08FFFFh 19 64/32 100000h-10FFFFh 088000h-08FFFFh 19 64/32 0F0000h-0FFFFh 078000h-07FFFFh 18 64/32 0F0000h-0EFFFFh 078000h-07FFFFh 17 64/32 0E0000h-0EFFFFh 070000h-07FFFFh 16 64/32 0D0000h-00FFFFh 068000h-06FFFFh 15 64/32 0D0000h-00FFFFh 068000h-06FFFFh 14 64/32 0D0000h-00FFFFh 068000h-06FFFFh 13 64/32 0A0000h-0AFFFFh 058000h-05FFFFh 14 64/32 0A0000h-0AFFFFh 058000h-04FFFFh 12 64/32 0A0000h-03FFFFh 048000h-04FFFFh 14 64/32 070000h-07FFFFh 038000h-03FFFFh <td>26</td> <td>64/32</td> <td>170000h-17FFFFh</td> <td>0B8000h-0BFFFFh</td>	26	64/32	170000h-17FFFFh	0B8000h-0BFFFFh		
23 64/32 140000h-14FFFFh 0A0000h-037FFFh 22 64/32 130000h-13FFFFh 098000h-097FFFh 21 64/32 120000h-12FFFFh 090000h-097FFFh 20 64/32 110000h-11FFFFh 088000h-08FFFFh 19 64/32 100000h-10FFFFh 080000h-08FFFFh 19 64/32 0F0000h-0FFFFFh 078000h-07FFFFh 18 64/32 0F0000h-0FFFFFh 078000h-07FFFFh 17 64/32 0E0000h-0EFFFFh 070000h-07FFFFh 16 64/32 0D0000h-0DFFFFh 068000h-06FFFFh 15 64/32 0C0000h-02FFFFh 068000h-06FFFFh 14 64/32 0D0000h-03FFFFh 058000h-05FFFFh 13 64/32 0A0000h-0AFFFFh 058000h-03FFFFh 14 64/32 090000h-03FFFFh 040000h-04FFFFh 11 64/32 090000h-03FFFFh 040000h-03FFFFh 11 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 050000h-05FFFFh 028000h-02FFFFh <td>25</td> <td>64/32</td> <td>160000h-16FFFFh</td> <td>0B0000h-0B7FFFh</td>	25	64/32	160000h-16FFFFh	0B0000h-0B7FFFh		
22 64/32 130000h-13FFFh 098000h-09FFFh 21 64/32 120000h-12FFFh 090000h-097FFh 20 64/32 110000h-11FFFFh 088000h-08FFFFh 19 64/32 10000h-10FFFFh 080000h-087FFFh 19 64/32 0F0000h-0FFFFh 078000h-07FFFh 18 64/32 0F0000h-0EFFFFh 078000h-07FFFh 16 64/32 0D0000h-0EFFFFh 070000h-07FFFh 16 64/32 0D0000h-0EFFFFh 068000h-06FFFFh 15 64/32 0C0000h-0EFFFFh 068000h-06FFFFh 14 64/32 0C0000h-0FFFFh 068000h-05FFFFh 13 64/32 0A0000h-0AFFFFh 058000h-05FFFFh 14 64/32 0A0000h-0FFFFh 058000h-04FFFFh 12 64/32 090000h-08FFFFh 048000h-04FFFFh 14 64/32 070000h-07FFFFh 038000h-03FFFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 10 64/32 050000h-05FFFFh 028000h-02FFFFh <tr< td=""><td>24</td><td>64/32</td><td>150000h-15FFFFh</td><td>0A8000h-0AFFFFh</td></tr<>	24	64/32	150000h-15FFFFh	0A8000h-0AFFFFh		
21 64/32 120000h-12FFFFh 090000h-097FFFh 20 64/32 110000h-11FFFFh 088000h-08FFFFh 19 64/32 10000h-10FFFFh 08000h-08FFFFh 18 64/32 0F0000h-0FFFFFh 078000h-07FFFFh 17 64/32 0E0000h-0EFFFFh 070000h-07FFFFh 16 64/32 0D0000h-0DFFFFh 068000h-06FFFFh 15 64/32 0C0000h-0EFFFFh 068000h-06FFFFh 14 64/32 0D0000h-0BFFFFh 058000h-05FFFFh 13 64/32 0B0000h-0BFFFFh 058000h-05FFFFh 14 64/32 0B0000h-08FFFFh 058000h-05FFFFh 13 64/32 0A0000h-03FFFFh 048000h-04FFFFh 14 64/32 090000h-03FFFFh 048000h-03FFFFh 15 64/32 070000h-07FFFFh 038000h-03FFFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 10 64/32 050000h-05FFFFh 028000h-02FFFFh 10 64/32 050000h-03FFFFh 028000h-02FFFFh <td>23</td> <td>64/32</td> <td>140000h-14FFFFh</td> <td>0A0000h-0A7FFFh</td>	23	64/32	140000h-14FFFFh	0A0000h-0A7FFFh		
20 64/32 110000h-11FFFFh 088000h-08FFFFh 19 64/32 10000h-10FFFFh 08000h-087FFFh 18 64/32 0F0000h-0FFFFh 078000h-07FFFFh 17 64/32 0E0000h-0EFFFFh 070000h-077FFFh 16 64/32 0E0000h-0EFFFFh 068000h-06FFFFh 15 64/32 0C0000h-0DFFFFh 068000h-06FFFFh 14 64/32 0B0000h-08FFFFh 058000h-05FFFFh 13 64/32 0A0000h-08FFFFh 058000h-05FFFFh 14 64/32 0B0000h-08FFFFh 058000h-05FFFFh 12 64/32 0A0000h-08FFFFh 048000h-04FFFFh 11 64/32 090000h-08FFFFh 048000h-04FFFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 050000h-05FFFFh 038000h-02FFFFh 9 64/32 050000h-03FFFFh 028000h-02FFFFh 6 64/32 030000h-03FFFFh 018000h-02FFFFh 6 64/32 030000h-03FFFFh 018000h-01FFFFh	22	64/32	130000h-13FFFFh	098000h-09FFFFh		
19 64/32 100000h-10FFFFh 080000h-087FFFh 18 64/32 0F0000h-0FFFFh 078000h-077FFFh 17 64/32 0E0000h-0EFFFFh 070000h-077FFFh 16 64/32 0D0000h-0DFFFFh 068000h-067FFFh 15 64/32 0C0000h-0CFFFFh 066000h-067FFFh 14 64/32 0B0000h-0BFFFh 058000h-05FFFFh 13 64/32 0A0000h-0AFFFFh 058000h-05FFFFh 14 64/32 0B0000h-0BFFFFh 058000h-05FFFFh 12 64/32 090000h-09FFFFh 048000h-04FFFFh 11 64/32 090000h-03FFFFh 048000h-047FFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 050000h-05FFFFh 028000h-02FFFFh 9 64/32 050000h-03FFFFh 028000h-02FFFFh 6 64/32 030000h-03FFFFh 018000h-01FFFFh 5 64/32 030000h-03FFFFh 018000h-01FFFFh	21	64/32	120000h-12FFFFh	090000h-097FFFh		
18 64/32 0F0000h-0FFFFh 078000h-07FFFFh 17 64/32 0E0000h-0EFFFh 070000h-077FFFh 16 64/32 0D0000h-0DFFFFh 068000h-06FFFFh 15 64/32 0C0000h-0CFFFFh 066000h-067FFFh 14 64/32 0B0000h-0AFFFFh 058000h-057FFFh 13 64/32 0A0000h-0AFFFFh 050000h-057FFFh 12 64/32 090000h-03FFFFh 048000h-04FFFFh 11 64/32 090000h-03FFFFh 048000h-04FFFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 070000h-07FFFFh 030000h-03FFFFh 9 64/32 050000h-05FFFFh 028000h-02FFFFh 7 64/32 050000h-03FFFFh 028000h-02FFFFh 6 64/32 03000h-03FFFFh 018000h-01FFFFh 5 64/32 020000h-02FFFFh 010000h-01FFFFh 4 64/32 010000h-01FFFFh 0080800h-00FFFFh <	20	64/32	110000h-11FFFFh	088000h-08FFFFh		
17 64/32 0E0000h-0EFFFh 070000h-077FFFh 16 64/32 0D0000h-0DFFFh 068000h-06FFFh 15 64/32 0C0000h-0CFFFFh 060000h-067FFFh 14 64/32 0B0000h-0BFFFh 058000h-05FFFh 13 64/32 0A0000h-0AFFFFh 050000h-057FFFh 12 64/32 090000h-09FFFh 048000h-04FFFFh 11 64/32 090000h-08FFFFh 048000h-04FFFFh 11 64/32 090000h-08FFFFh 048000h-04FFFFh 11 64/32 090000h-08FFFFh 048000h-04FFFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 050000h-05FFFFh 028000h-02FFFFh 7 64/32 050000h-03FFFFh 028000h-02FFFFh 6 64/32 030000h-03FFFFh 018000h-01FFFFh 5 64/32 020000h-02FFFFh 010000h-01FFFFh 4 64/32 010000h-01FFFFh 0080000h-00FFFFh <t< td=""><td>19</td><td>64/32</td><td>100000h-10FFFFh</td><td>080000h-087FFFh</td></t<>	19	64/32	100000h-10FFFFh	080000h-087FFFh		
16 64/32 0D0000h-0DFFFFh 068000h-06FFFh 15 64/32 0C0000h-0CFFFFh 060000h-067FFFh 14 64/32 0B0000h-0BFFFh 058000h-05FFFh 13 64/32 0A0000h-0AFFFFh 050000h-057FFFh 12 64/32 090000h-09FFFFh 048000h-04FFFFh 11 64/32 090000h-09FFFFh 048000h-04FFFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 050000h-05FFFFh 030000h-03FFFFh 9 64/32 050000h-05FFFFh 028000h-02FFFFh 7 64/32 050000h-03FFFFh 028000h-02FFFFh 6 64/32 030000h-03FFFFh 018000h-01FFFFh 6 64/32 020000h-02FFFFh 018000h-01FFFFh 4 64/32 010000h-01FFFFh 008000h-00FFFFh 3 32/16 008000h-00FFFFh 003000h-003FFFFh 1 8/4 006000h-007FFFh 0020000h-002FFFFh <td>18</td> <td>64/32</td> <td>0F0000h-0FFFFh</td> <td>078000h-07FFFFh</td>	18	64/32	0F0000h-0FFFFh	078000h-07FFFFh		
15 64/32 0C0000h-0CFFFFh 060000h-067FFFh 14 64/32 0B0000h-0BFFFFh 058000h-05FFFh 13 64/32 0A0000h-0AFFFFh 050000h-057FFFh 12 64/32 090000h-09FFFh 048000h-04FFFFh 11 64/32 090000h-09FFFh 040000h-04FFFFh 11 64/32 080000h-08FFFFh 040000h-04FFFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 050000h-05FFFFh 028000h-03FFFFh 9 64/32 050000h-05FFFFh 028000h-02FFFFh 7 64/32 050000h-03FFFFh 028000h-02FFFFh 6 64/32 030000h-03FFFFh 018000h-01FFFFh 6 64/32 030000h-03FFFFh 018000h-01FFFFh 6 64/32 020000h-02FFFFh 018000h-00FFFFh 4 64/32 010000h-01FFFFh 008000h-00FFFFh 3 32/16 008000h-00FFFFh 0030000h-003FFFh <tr< td=""><td>17</td><td>64/32</td><td>0E0000h-0EFFFFh</td><td>070000h-077FFFh</td></tr<>	17	64/32	0E0000h-0EFFFFh	070000h-077FFFh		
14 64/32 0B0000h-0BFFFFh 058000h-05FFFFh 13 64/32 0A0000h-0AFFFFh 050000h-057FFFh 12 64/32 090000h-09FFFFh 048000h-04FFFFh 11 64/32 080000h-08FFFFh 040000h-04FFFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 060000h-06FFFFh 030000h-03FFFFh 9 64/32 050000h-05FFFFh 028000h-02FFFFh 7 64/32 050000h-03FFFFh 028000h-02FFFFh 6 64/32 030000h-03FFFFh 018000h-017FFFh 6 64/32 030000h-02FFFFh 018000h-01FFFFh 5 64/32 020000h-02FFFFh 010000h-017FFFh 4 64/32 010000h-01FFFFh 008000h-00FFFFh 3 32/16 008000h-00FFFFh 004000h-003FFFFh 2 8/4 006000h-007FFFh 003000h-003FFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	16	64/32	0D0000h-0DFFFFh	068000h-06FFFFh		
13 64/32 0A0000h-0AFFFFh 050000h-057FFFh 12 64/32 090000h-09FFFh 048000h-04FFFFh 11 64/32 080000h-08FFFFh 040000h-047FFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 060000h-06FFFFh 038000h-03FFFFh 9 64/32 050000h-05FFFFh 028000h-03FFFFh 8 64/32 050000h-05FFFFh 028000h-02FFFFh 7 64/32 050000h-03FFFFh 028000h-02FFFFh 6 64/32 030000h-03FFFFh 018000h-017FFFh 5 64/32 020000h-02FFFFh 018000h-017FFFh 4 64/32 010000h-01FFFFh 008000h-00FFFFh 3 32/16 008000h-00FFFFh 004000h-007FFFh 2 8/4 006000h-007FFFh 003000h-003FFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	15	64/32	0C0000h-0CFFFFh	060000h-067FFFh		
12 64/32 090000h-09FFFFh 048000h-04FFFFh 11 64/32 080000h-08FFFFh 040000h-047FFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 060000h-06FFFFh 030000h-037FFFh 8 64/32 050000h-05FFFFh 028000h-02FFFFh 7 64/32 040000h-04FFFFh 020000h-027FFFh 6 64/32 030000h-03FFFFh 018000h-027FFFh 6 64/32 030000h-03FFFFh 018000h-017FFFh 6 64/32 020000h-02FFFFh 010000h-017FFFh 5 64/32 020000h-02FFFFh 010000h-017FFFh 4 64/32 010000h-01FFFFh 008000h-00FFFFh 3 32/16 008000h-00FFFFh 004000h-003FFFh 2 8/4 006000h-007FFFh 003000h-003FFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	14	64/32	0B0000h-0BFFFFh	058000h-05FFFFh		
11 64/32 080000h-08FFFFh 040000h-047FFFh 10 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 060000h-06FFFFh 030000h-037FFFh 8 64/32 050000h-05FFFFh 028000h-02FFFFh 7 64/32 040000h-04FFFFh 028000h-02FFFFh 6 64/32 040000h-04FFFFh 028000h-02FFFFh 6 64/32 040000h-04FFFFh 020000h-02FFFFh 6 64/32 030000h-03FFFFh 018000h-01FFFFh 5 64/32 020000h-02FFFFh 010000h-01FFFFh 4 64/32 010000h-01FFFFh 008000h-00FFFFh 3 32/16 008000h-00FFFFh 004000h-003FFFFh 2 8/4 006000h-007FFFh 003000h-003FFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	13	64/32	0A0000h-0AFFFFh	050000h-057FFFh		
10 64/32 070000h-07FFFFh 038000h-03FFFFh 9 64/32 060000h-06FFFFh 030000h-037FFFh 8 64/32 050000h-05FFFFh 028000h-02FFFFh 7 64/32 040000h-04FFFFh 020000h-027FFFh 6 64/32 030000h-03FFFFh 018000h-01FFFFh 5 64/32 020000h-02FFFFh 018000h-01FFFFh 4 64/32 020000h-02FFFFh 010000h-01FFFFh 3 32/16 008000h-00FFFFh 004000h-007FFFh 2 8/4 006000h-007FFFh 003000h-003FFFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	12	64/32	090000h-09FFFFh	048000h-04FFFFh		
9 64/32 060000h-06FFFFh 030000h-037FFFh 8 64/32 050000h-05FFFh 028000h-02FFFh 7 64/32 040000h-04FFFFh 020000h-027FFFh 6 64/32 030000h-03FFFFh 018000h-01FFFFh 5 64/32 020000h-02FFFFh 010000h-017FFFh 4 64/32 010000h-01FFFFh 008000h-00FFFFh 3 32/16 008000h-00FFFFh 004000h-003FFFFh 2 8/4 006000h-007FFFh 003000h-003FFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	11	64/32	080000h-08FFFFh	040000h-047FFFh		
8 64/32 050000h-05FFFFh 028000h-02FFFFh 7 64/32 040000h-04FFFFh 020000h-027FFFh 6 64/32 030000h-03FFFFh 018000h-01FFFFh 5 64/32 020000h-02FFFFh 010000h-01FFFFh 4 64/32 020000h-01FFFFh 008000h-00FFFFh 3 32/16 008000h-00FFFFh 004000h-007FFFh 2 8/4 006000h-007FFFh 003000h-003FFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	10	64/32	070000h-07FFFFh	038000h-03FFFFh		
7 64/32 040000h-04FFFFh 020000h-027FFFh 6 64/32 030000h-03FFFh 018000h-01FFFh 5 64/32 020000h-02FFFFh 010000h-017FFFh 4 64/32 010000h-01FFFFh 008000h-00FFFFh 3 32/16 008000h-00FFFFh 004000h-007FFFh 2 8/4 006000h-007FFFh 003000h-003FFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	9	64/32	060000h-06FFFFh	030000h-037FFFh		
6 64/32 030000h-03FFFFh 018000h-01FFFFh 5 64/32 020000h-02FFFFh 010000h-017FFFh 4 64/32 010000h-01FFFFh 008000h-00FFFFh 3 32/16 008000h-00FFFFh 004000h-007FFFh 2 8/4 006000h-007FFFh 003000h-003FFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	8	64/32	050000h-05FFFFh	028000h-02FFFFh		
5 64/32 020000h-02FFFFh 010000h-017FFFh 4 64/32 010000h-01FFFFh 008000h-00FFFFh 3 32/16 008000h-00FFFFh 004000h-007FFFh 2 8/4 006000h-007FFFh 003000h-003FFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	7	64/32	040000h-04FFFFh	020000h-027FFFh		
4 64/32 010000h-01FFFFh 008000h-00FFFFh 3 32/16 008000h-00FFFFh 004000h-007FFFh 2 8/4 006000h-007FFFh 003000h-003FFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	6	64/32	030000h-03FFFFh	018000h-01FFFFh		
3 32/16 008000h-00FFFFh 004000h-007FFFh 2 8/4 006000h-007FFFh 003000h-003FFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	5	64/32	020000h-02FFFFh	010000h-017FFFh		
2 8/4 006000h-007FFFh 003000h-003FFFh 1 8/4 004000h-005FFFh 002000h-002FFFh	4	64/32	010000h-01FFFFh	008000h-00FFFFh		
1 8/4 004000h-005FFFh 002000h-002FFFh	3	32/16	008000h-00FFFFh	004000h-007FFFh		
	2	8/4	006000h-007FFFh	003000h-003FFFh		
0 16/8 000000h-003FFFh 000000h-001FFFh	1	8/4	004000h-005FFFh	002000h-002FFFh		
	0	16/8	000000h-003FFFh	000000h-001FFFh		

 Table 20.
 Bottom Boot Block Addresses, M29W320DB (continued)



Appendix B Common Flash Interface (CFI)

The Common Flash Interface is a JEDEC approved, standardized data structure that can be read from the Flash memory device. It allows a system software to query the device to determine various electrical and timing parameters, density information and functions supported by the memory. The system can interface easily with the device, enabling the software to upgrade itself when necessary.

When the CFI Query Command is issued the device enters CFI Query mode and the data structure is read from the memory. *Table 21, Table 22, Table 23, Table 24, Table 25* and *Table 26* show the addresses used to retrieve the data. The CFI data structure also contains a security area where a 64 bit unique security number is written (see *Table 26*, Security Code area). This area can be accessed only in Read mode by the final user. It is impossible to change the security number after it has been written by ST. Issue a Read command to return to Read mode.

 Table 21.
 Query Structure Overview⁽¹⁾

Address		Sub-section Name	Description	
x16	x8	Sub-section Name	Description	
10h	20h	CFI Query Identification String	Command set ID and algorithm data offset	
1Bh	36h	System Interface Information	Device timing & voltage information	
27h	4Eh	Device Geometry Definition	Flash device layout	
40h	80h	Primary Algorithm-specific Extended Query table	Additional information specific to the Primary Algorithm (optional)	
61h	C2h	Security Code Area	64 bit unique device number	

1. Query data are always presented on the lowest order data outputs.

Table 22. CFI Query Identification String⁽¹⁾

Add	Address Dat		Description	Value	
x16	x8	Data	Description	value	
10h	20h	0051h		"Q"	
11h	22h	0052h	Query Unique ASCII String "QRY"	"R"	
12h	24h	0059h		"Y"	
13h	26h	0002h	Primary Algorithm Command Set and Control Interface ID code 16 bit		
14h	28h	0000h	ID code defining a specific algorithm	AMD Compatible	
15h	2Ah	0040h	Address for Brimery Algerithm extended Query table (see Table 24)	P = 40h	
16h	2Ch	0000h	Address for Primary Algorithm extended Query table (see <i>Table 24</i>)	P = 40n	
17h	2Eh	0000h	Alternate Vendor Command Set and Control Interface ID Code	NA	
18h	30h	0000h	second vendor - specified algorithm supported	NA	
19h	32h	0000h	Address for Alternate Algerithm extended Query table	NA	
1Ah	34h	0000h	Address for Alternate Algorithm extended Query table	INA	

1. Query data are always presented on the lowest order data outputs (DQ7-DQ0) only. DQ8-DQ15 are '0'.



Add	Address		Description		
x16	x8	Data	Description	Value	
1Bh	36h	0027h	V _{CC} Logic Supply Minimum Program/Erase voltage bit 7 to 4BCD value in volts bit 3 to 0BCD value in 100 mV	2.7V	
1Ch	38h	0036h	V _{CC} Logic Supply Maximum Program/Erase voltage bit 7 to 4BCD value in volts bit 3 to 0BCD value in 100 mV	3.6V	
1Dh	3Ah	00B5h	V _{PP} [Programming] Supply Minimum Program/Erase voltage bit 7 to 4HEX value in volts bit 3 to 0BCD value in 100 mV	11.5V	
1Eh	3Ch	00C5h	V _{PP} [Programming] Supply Maximum Program/Erase voltage bit 7 to 4HEX value in volts bit 3 to 0BCD value in 100 mV	12.5V	
1Fh	3Eh	0004h	Typical timeout per single byte/word program = $2^{n} \mu s$	16µs	
20h	40h	0000h	Typical timeout for minimum size write buffer program = $2^{n} \mu s$	NA	
21h	42h	000Ah	Typical timeout per individual block erase = 2 ⁿ ms	1s	
22h	44h	0000h	Typical timeout for full chip erase = 2^{n} ms	NA	
23h	46h	0005h	Maximum timeout for byte/word program = 2 ⁿ times typical	512µs	
24h	48h	0000h	Maximum timeout for write buffer program = 2 ⁿ times typical	NA	
25h	4Ah	0004h	Maximum timeout per individual block erase = 2 ⁿ times typical	16s	
26h	4Ch	0000h	Maximum timeout for chip erase = 2^n times typical	NA	

Table 23.	CFI Query System Interface Information
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Add	Address		Description	Value
x16	x8	Data	Description	Value
27h	4Eh	0016h	Device Size = 2 ⁿ in number of bytes	4 MByte
28h 29h	50h 52h	0002h 0000h	Flash Device Interface Code description	x8, x16 Async.
2Ah 2Bh	54h 56h	0000h 0000h	Maximum number of bytes in multi-byte program or page = 2 ⁿ	NA
2Ch	58h	0004h	Number of Erase Block Regions within the device. It specifies the number of regions within the device containing contiguous Erase Blocks of the same size.	4
2Dh 2Eh	5Ah 5Ch	0000h 0000h	Region 1 Information Number of identical size erase block = 0000h+1	1
2Fh 30h	5Eh 60h	0040h 0000h	Region 1 Information Block size in Region 1 = 0040h * 256 byte	16 Kbyte



Add	lress	Data	Data Description	
x16	x8	Data	Description	Value
31h	62h	0001h	Region 2 Information	2
32h	64h	0000h	Number of identical size erase block = 0001h+1	
33h	66h	0020h	Region 2 Information	8 Kbyte
34h	68h	0000h	Block size in Region 2 = 0020h * 256 byte	
35h	6Ah	0000h	Region 3 Information	1
36h	6Ch	0000h	Number of identical size erase block = 0000h+1	
37h	6Eh	0080h	Region 3 Information	32 Kbyte
38h	70h	0000h	Block size in Region 3 = 0080h * 256 byte	
39h	72h	003Eh	Region 4 Information	63
3Ah	74h	0000h	Number of identical-size erase block = 003Eh+1	
3Bh	76h	0000h	Region 4 Information	64 Kbyte
3Ch	78h	0001h	Block size in Region 4 = 0100h * 256 byte	

Table 24.	Device Geometr	y Definition	(continued))
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Table 25.	Primary Algorithm-Specific Extended Query	Table
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Ado	Address		lress Data			Value
x16	x8	Dala	Description			
40h	80h	0050h		"P"		
41h	82h	0052h	Primary Algorithm extended Query table unique ASCII string "PRI"	"R"		
42h	84h	0049h		" "		
43h	86h	0031h	Major version number, ASCII	"1"		
44h	88h	0030h	Minor version number, ASCII	"0"		
45h	8Ah	0000h	ddress Sensitive Unlock (bits 1 to 0) 0 = required, 01= not required illicon Revision Number (bits 7 to 2)			
46h	8Ch	0002h	Erase Suspend 00 = not supported, 01 = Read only, 02 = Read and Write			
47h	8Eh	0001h	Block Protection 00 = not supported, x = number of blocks in per group			
48h	90h	0001h	Temporary Block Unprotect 00 = not supported, 01 = supported	Yes		
49h	92h	0004h	Block Protect /Unprotect 04 = M29W400B	4		
4Ah	94h	0000h	Simultaneous Operations, 00 = not supported			
4Bh	96h	0000h	Burst Mode, 00 = not supported, 01 = supported	No		
4Ch	98h	0000h	Page Mode, 00 = not supported, 01 = 4 page word, 02 = 8 page word	No		

Add	ress	Data	Dete Description	
x16	x8	Dala	Description	Value
4Dh	9Ah	00B5h	V _{PP} Supply Minimum Program/Erase voltage bit 7 to 4 HEX value in volts bit 3 to 0 BCD value in 100 mV	11.5V
4Eh	9Ch	00C5h	V _{PP} Supply Minimum Program/Erase voltage bit 7 to 4 HEX value in volts bit 3 to 0 BCD value in 100 mV	12.5V
4Fh	9Eh	000xh	Top/Bottom Boot Block Flag 02h = Bottom Boot device, 03h = Top Boot device	_

Table 25. Primary Algorithm-Specific Extended Query Table (continued)

Table 26.Security Code Area

Ade	Address		Description	
x16	x8	Data	Description	
61h	C3h, C2h	XXXX		
62h	C5h, C4h	XXXX	64 bit: unique device number	
63h	C7h, C6h	XXXX		
64h	C9h, C8h	XXXX		



Appendix C Block Protection

Block protection can be used to prevent any operation from modifying the data stored in the Flash. Each Block can be protected individually. Once protected, Program and Erase operations on the block fail to change the data.

There are three techniques that can be used to control Block Protection, these are the Programmer technique, the In-System technique and Temporary Unprotection. Temporary Unprotection is controlled by the Reset/Block Temporary Unprotection pin, \overline{RP} ; this is described in the Signal Descriptions section.

Unlike the Command Interface of the Program/Erase Controller, the techniques for protecting and unprotecting blocks change between different Flash memory suppliers. For example, the techniques for AMD parts will not work on STMicroelectronics parts. Care should be taken when changing drivers for one part to work on another.

C.1 Programmer Technique

The Programmer technique uses high (V_{ID}) voltage levels on some of the bus pins. These cannot be achieved using a standard microprocessor bus, therefore the technique is recommended only for use in Programming Equipment.

To protect a block follow the flowchart in *Figure 16: Programmer Equipment Block Protect Flowchart.* To unprotect the whole chip it is necessary to protect all of the blocks first, then all blocks can be unprotected at the same time. To unprotect the chip follow *Figure 17: Programmer Equipment Chip Unprotect Flowchart. Table 27: Programmer Technique Bus Operations, BYTE = VIHor VIL*, gives a summary of each operation.

The timing on these flowcharts is critical. Care should be taken to ensure that, where a pause is specified, it is followed as closely as possible. Do not abort the procedure before reaching the end. Chip Unprotect can take several seconds and a user message should be provided to show that the operation is progressing.

C.2 In-System Technique

The In-System technique requires a high voltage level on the Reset/Blocks Temporary Unprotect pin, RP. This can be achieved without violating the maximum ratings of the components on the microprocessor bus, therefore this technique is suitable for use after the Flash has been fitted to the system.

To protect a block follow the flowchart in *Figure 18: In-System Equipment Block Protect Flowchart*. To unprotect the whole chip it is necessary to protect all of the blocks first, then all the blocks can be unprotected at the same time. To unprotect the chip follow Figure *Figure 19: In-System Equipment Chip Unprotect Flowchart*.

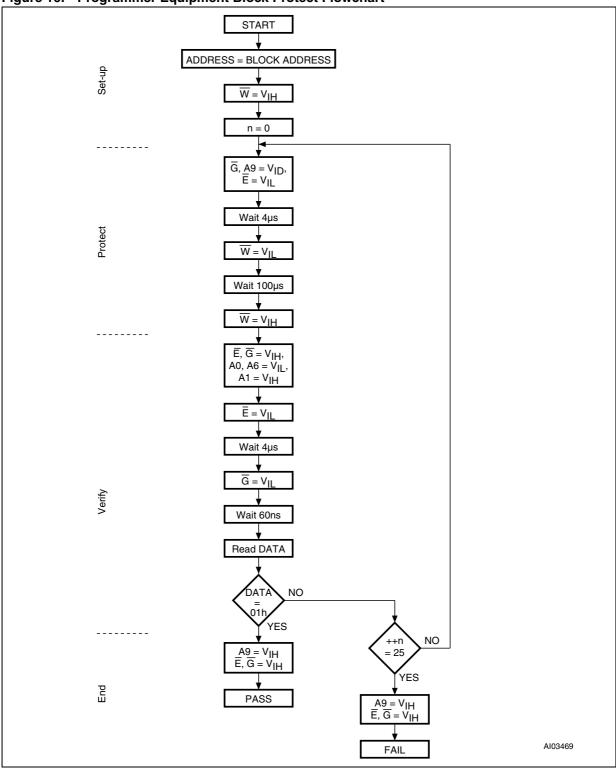
The timing on these flowcharts is critical. Care should be taken to ensure that, where a pause is specified, it is followed as closely as possible. Do not allow the microprocessor to service interrupts that will upset the timing and do not abort the procedure before reaching the end. Chip Unprotect can take several seconds and a user message should be provided to show that the operation is progressing.



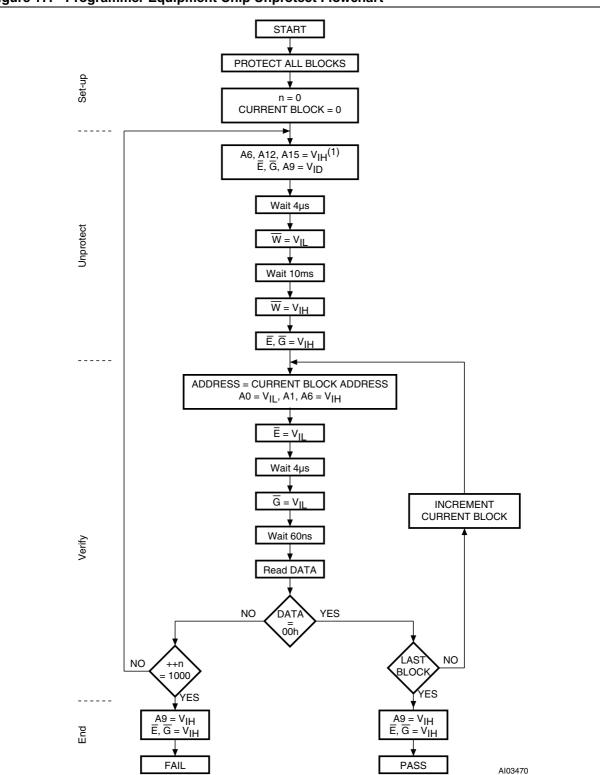
Operation	Ē	G	W	Address Inputs A0-A20	Data Inputs/Outputs DQ15A–1, DQ14-DQ0
Block Protect	V _{IL}	V _{ID}	V _{IL} Pulse	A9 = V _{ID} , A12-A20 Block Address Others = X	Х
Chip Unprotect	V _{ID}	V _{ID}	V _{IL} Pulse	$\begin{array}{l} A9=V_{ID},A12=V_{IH},A15=V_{IH}\\ \text{Others}=X \end{array}$	х
Block Protection Verify	V _{IL}	V _{IL}	V _{IH}	$\begin{array}{l} A0=V_{IL}, A1=V_{IH}, A6=V_{IL}, A9=V_{ID},\\ A12\text{-}A20 \text{ Block Address}\\ Others=X \end{array}$	Pass = XX01h Retry = XX00h
Block Unprotection Verify	V _{IL}	V _{IL}	V _{IH}	$\begin{array}{l} A0=V_{IL},A1=V_{IH},A6=V_{IH},\\ A9=V_{ID},A12\text{-}A20\;Block\;Address\\ & Others=X \end{array}$	Retry = XX01h Pass = XX00h

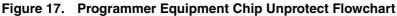
Table 27.Programmer Technique Bus Operations, $\overline{\text{BYTE}} = V_{\text{IH}}$ or V_{IL}













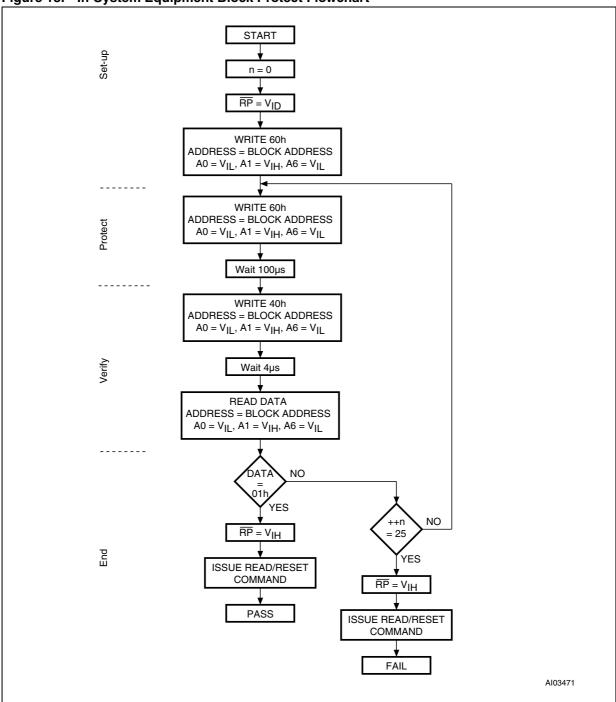


Figure 18. In-System Equipment Block Protect Flowchart

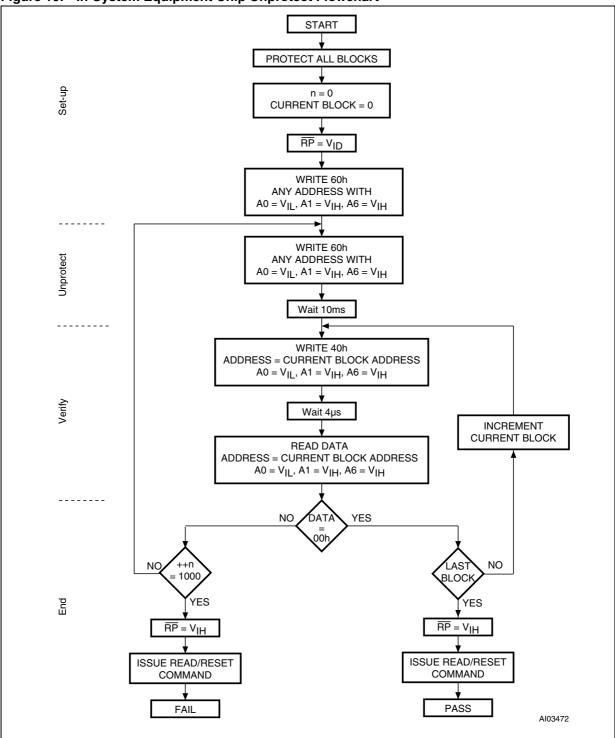


Figure 19. In-System Equipment Chip Unprotect Flowchart



10 Revision history

-	Table 28.	Do	cument revi	sion	history	

Date	Revision	Changes		
March-2001	-01	First Issue (Brief Data)		
08-Jun-2001	-02	Document expanded to full Product Preview		
22-Jun-2001	-03	Minor text corrections to Read/Reset and Read CFI commands and Status Register Error and Toggle Bits.		
27-Jul-2001	-04	Document type: from Product Preview to Preliminary Data TFBGA connections and Block Addresses (x16) diagrams clarification Write Protect and Block Unprotect clarification CFI Primary Algorithm table, Block Protection change		
05-Oct-2001	-05	Added Block Protection Appendix "Write Protect/V _{PP} " pin renamed to "V _{PP} /Write Protect" to be consistent with abbreviation. Changes to the V _{PP} /WP pin description, <i>Figure 13</i> and <i>Table 15</i> . I _{PP} added to <i>Table 11</i> and I _{CC3} clarified. Modified description of V _{PP} /WP operation in Unlock Bypass Command section. Added V _{PP} /WP decoupling capacitor to Figure <i>Figure 1</i> . Clarified Read/Reset operation during Erase Suspend.		
07-Feb-2002	-06	TFBGA package changed from 48 ball to 63 ball		
05-Apr-2002	-07	Description of Ready/Busy signal clarified (and <i>Figure 12</i> modified) Clarified allowable commands during block erase Clarified the mode the device returns to in the CFI Read Query command section		
19-Nov-2002	7.1	Erase Suspend Latency Time (typical and maximum) added to Program, Erase Times and Program, Erase Endurance Cycles table. Typical values added for Icc1 and Icc2 in DC characteristics table. Logic Diagram and Data Toggle Flowchart corrected. Revision numbering modified: a minor revision will be indicated by incrementing the digit after the dot, and a major revision, by incrementing the digit before the dot (revision version 07 equals 7.0). Document promoted to full datasheet.		
26-May-2003	7.2	Data Retention added to <i>Table 6: Program, Erase Times and</i> <i>Program, Erase Endurance Cycles</i> , and Typical after 100k W/E Cycles column removed. TSOP48 package mechanical updated. Lead-free package options E and F added to <i>Table 18: Ordering</i> <i>Information Scheme</i> .		



Date	Revision	Changes
16-Aug-2005	8.0	TFBGA48 package added throughout document.
13-Jun-2006	9	Document title modified. TFBGA63 package removed. ECOPACK text added. RB signal updated in <i>Figure 12: Reset/Block Temporary Unprotect</i> <i>AC Waveforms</i> . t _{PLYH} updated in <i>Table 15: Reset/Block Temporary</i> <i>Unprotect AC Characteristics</i> . In <i>Table 7: Status Register Bits</i> , DQ7 changed to DQ7 for Program, Program during Erase Suspend and Program Error.

 Table 28.
 Document revision history (continued)



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